

Challenges in Beam Intercepting Devices and Targetry technology for CERN's accelerator complex

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Sources, Targets and Interactions Group



ENGINEERING
DEPARTMENT



10th
Anniversary

J-PARC Symposium 2019

Disclaimer & acknowledgments

- Only a subset of the different palette of activities will be discussed, focusing on **specific challenges** and **examples on how these are been tackled**
- A. Perillo-Marccone, F.-X. Nuiiry, I. Lamas Garcia, S. Gilardoni, D. Carbajo, S. Pianese, A. Lechner, J. Maestre, C. Bahamonde, T. Polzin

Beam Intercepting Devices

Safety
function

Beam
stoppers

**Beam
dumps**

Beam cleaning
& control

Collimators

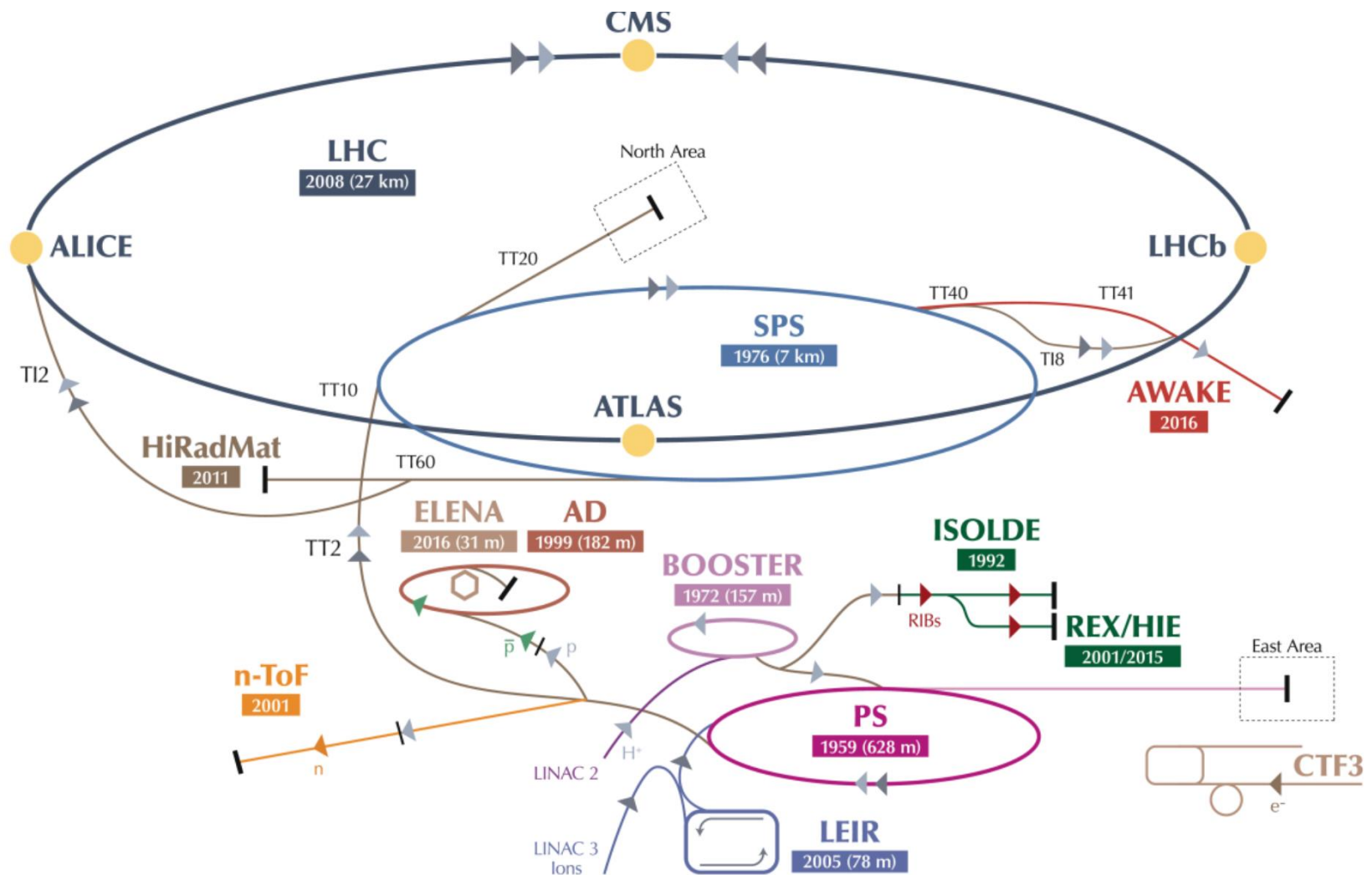
Scrapers

Strippers

Slits

Physics

Particle
producing
targets

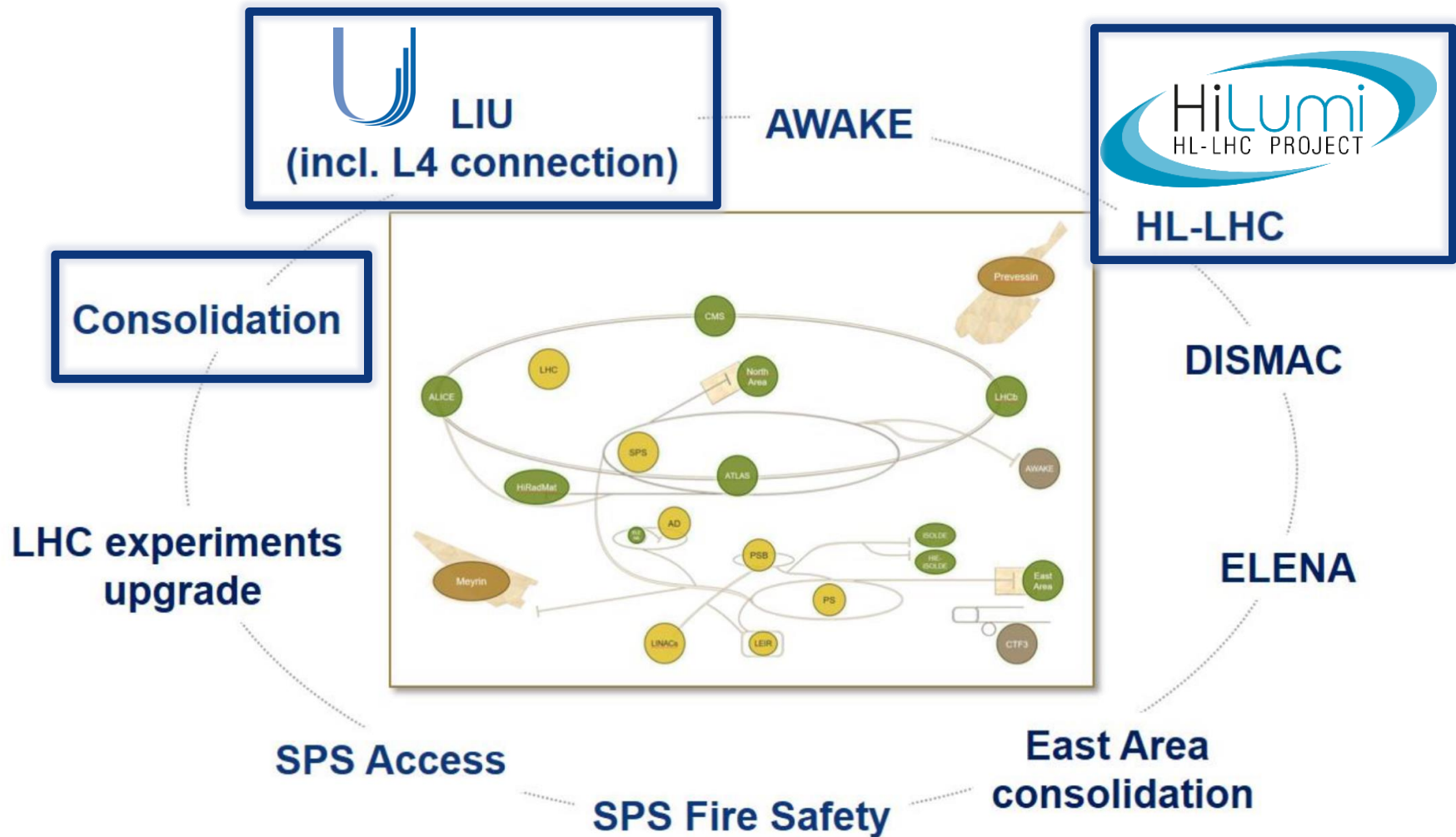


~250 devices scattered from the Linac chopper dump (3 MeV) to the LHC main dump (7 TeV)

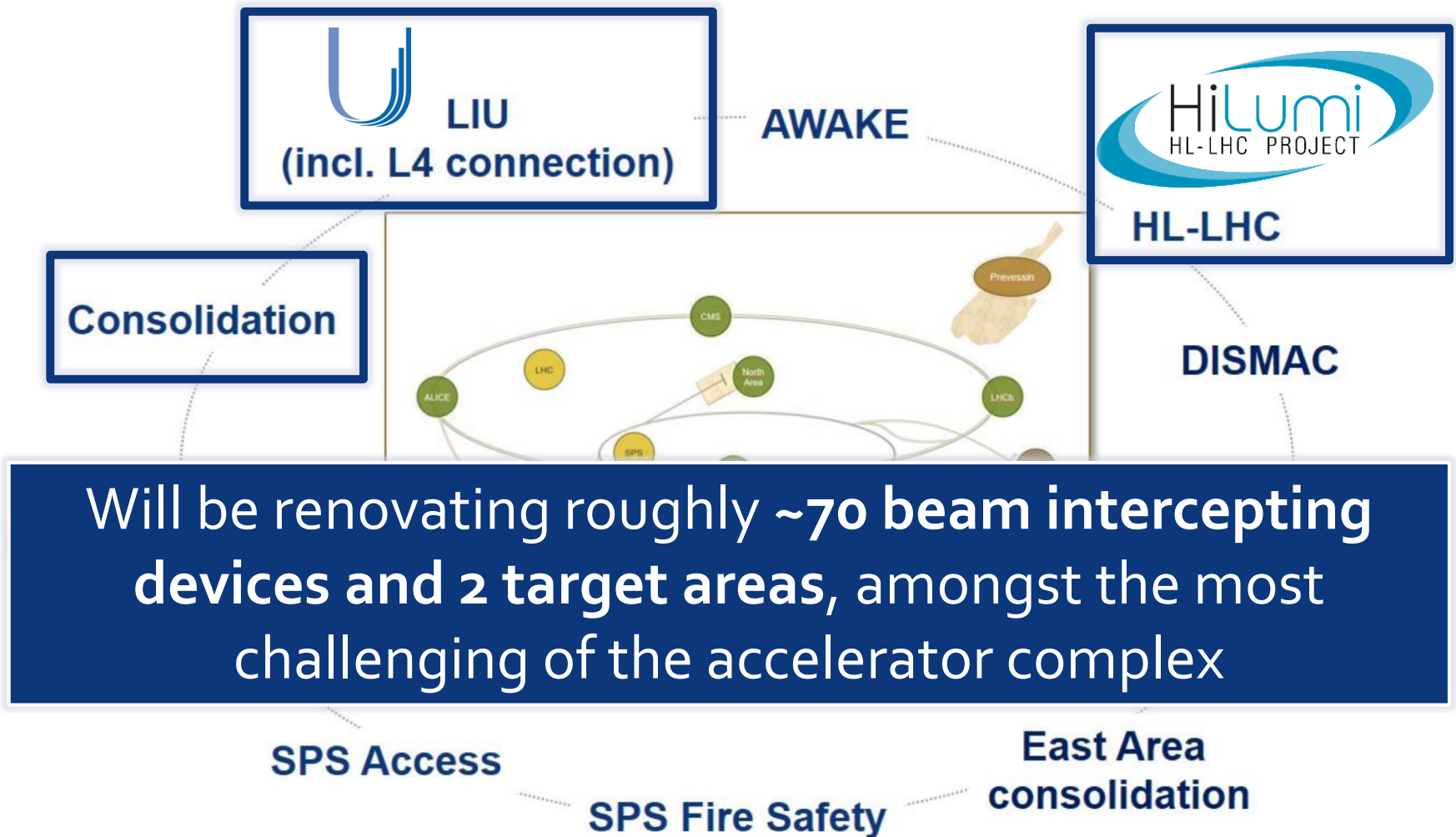
What type of challenges do we have?

- Devices must be able to withstand **operation** and **accident** scenarios, plus protect delicate equipment
 1. **UHV** requirements (10^{-10} mbar) also in *movable* parts
 2. **High energy densities** (\sim kJ/cm³/pulse) as well **power densities** (several MW/cm³)
 3. **High beam intensity/energy** (\sim 500 MJ for LHC dump)
 4. **High average deposited power** (\sim 250 kW for LIU SPS beam dump or \sim 350 kW for Beam Dump Facility)
 5. **Physics requirements**, often implying the use of non-structural materials (Pb or Ir)
 6. **Impedance**, especially for colliders
 7. **Radiation damage** on absorbing materials

What we are doing for LS2



What we are doing for LS2



LHC collimators

- Complex movable devices in UHV, roughly **100 devices**
- Water cooled brazed Glidcop jaws with CfC, MoGR and Inermet

High energy density

LHC beam dump (2x)

- 300 MJ of dissipated energy
- 500 MJ >2021, 720 MJ from 2026

High beam energy

LHC injection dump (2x)

- 5 m long device, moving in UHV with 10 μm precision
- Sandwich of graphite, Cu, TZM backstiffener

High energy density

SPS internal beam dump

- 26-450 GeV/c
- Water cooled – graphite absorber in CuCrZr mass
- 70 kW \rightarrow 250 kW from 2021

High average deposited power

PS Internal beam dump

- 1.4-26 GeV/c
- ~100 kJ circulating energy
- Movable dump in UHV
- Graphite with HIP CuCrZr

UHV and movable devices

2001

SPS
1976 (7 km)

PS
1959 (628 m)

LEIR
2005 (78 m)

AWAKE
2016

REX/HIE
2001/2015

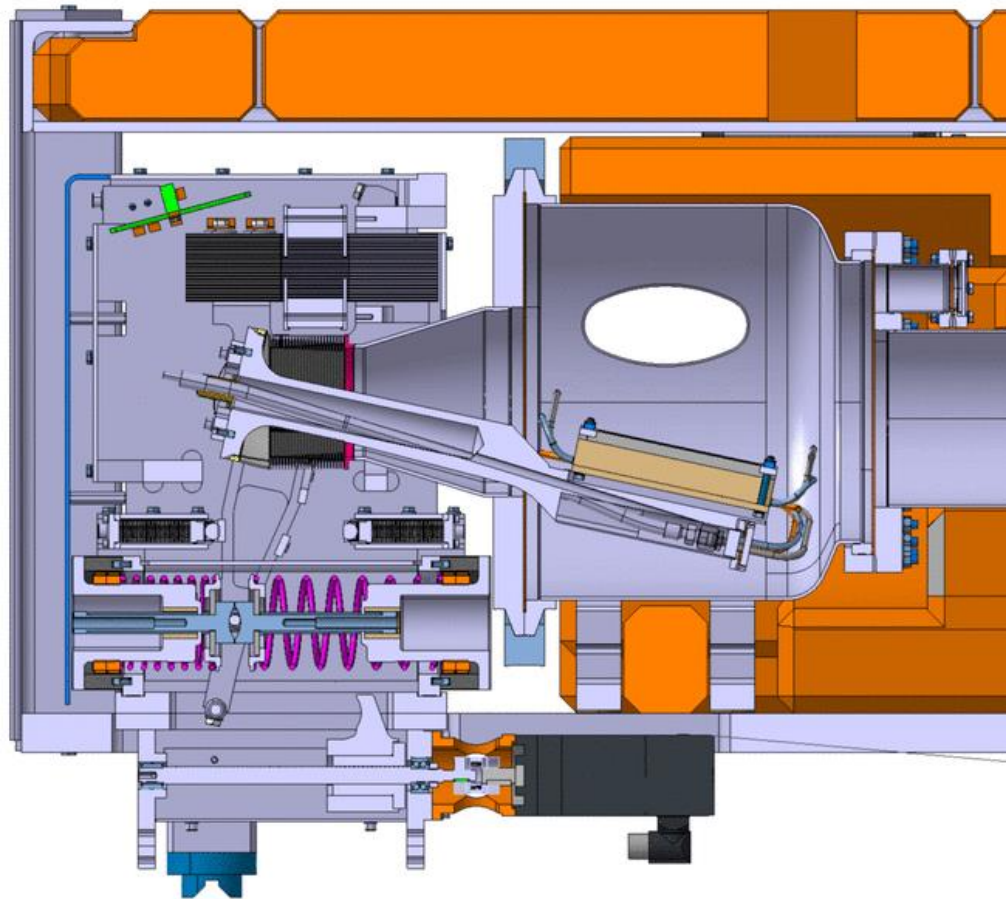
East Area

CTF3

e⁻

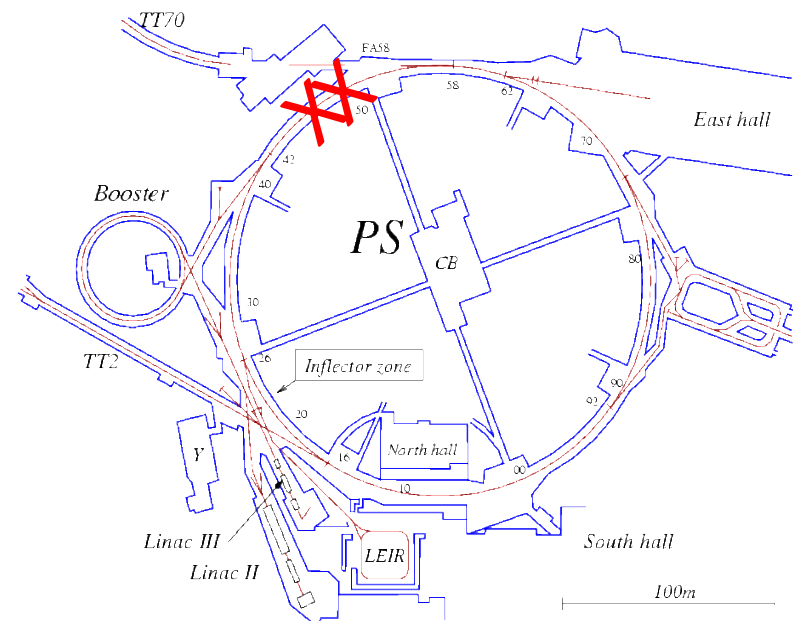
Some examples

Challenge: UHV and movable parts

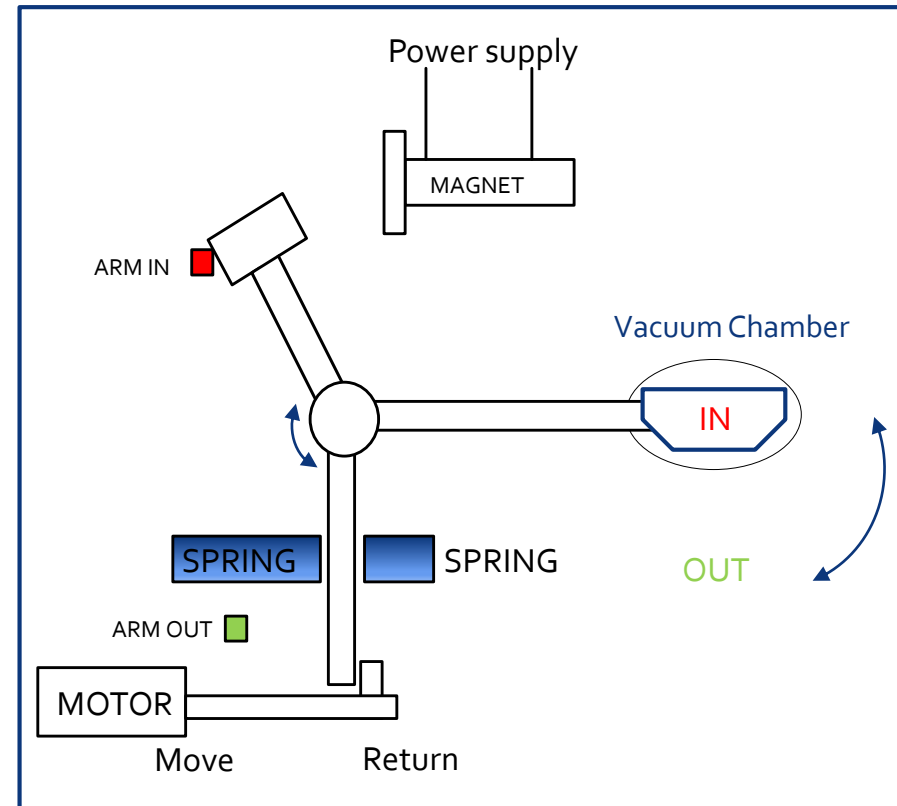
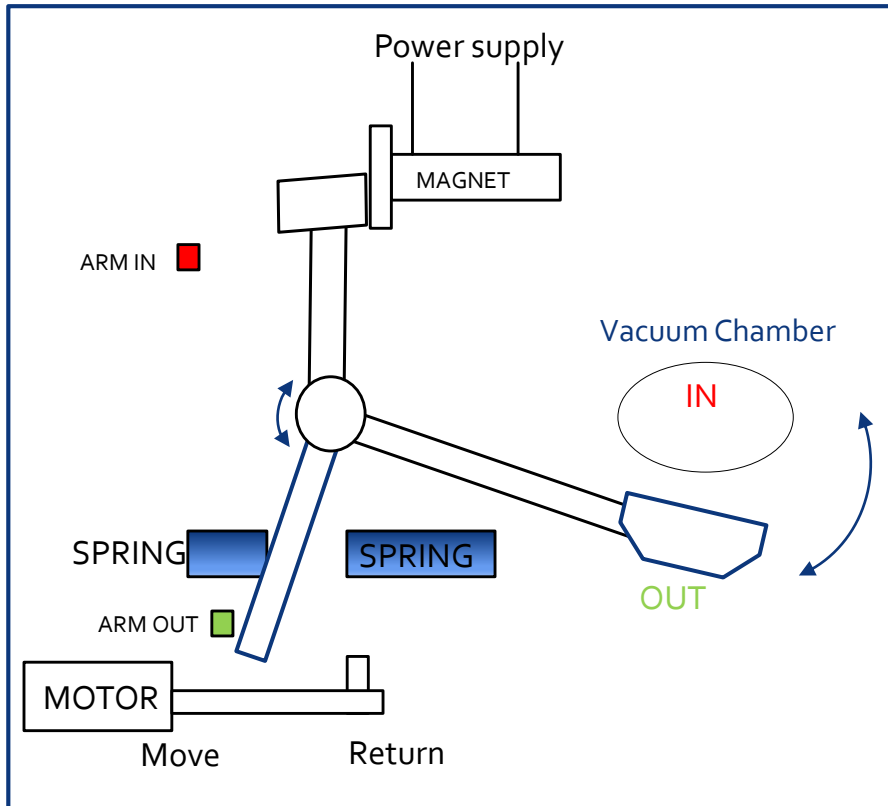


PS Internal Dump

- Main dump(s) of the CERN's Proton Synchrotron
- Beam up to 200 kJ, could have to cope with 80 kW
- Due to PS configuration, the dump are **movable devices in UHV**



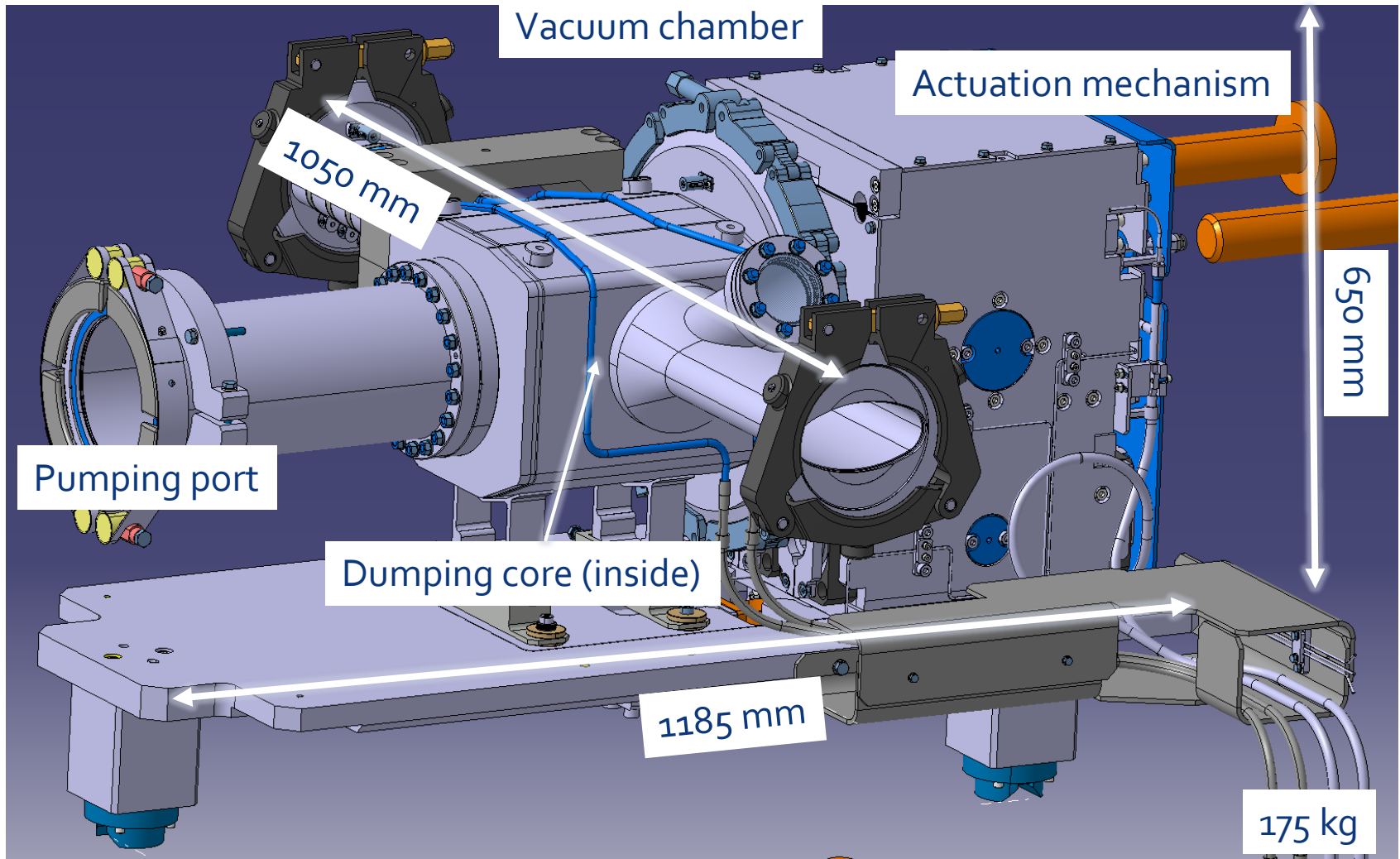
- Cycle time ~300 ms
- Revolution time of PS 2.1 μ s
- Dump is shaving/scraping the beam over the cycle time, ~150k revolutions
- Dump mass ~10 kg



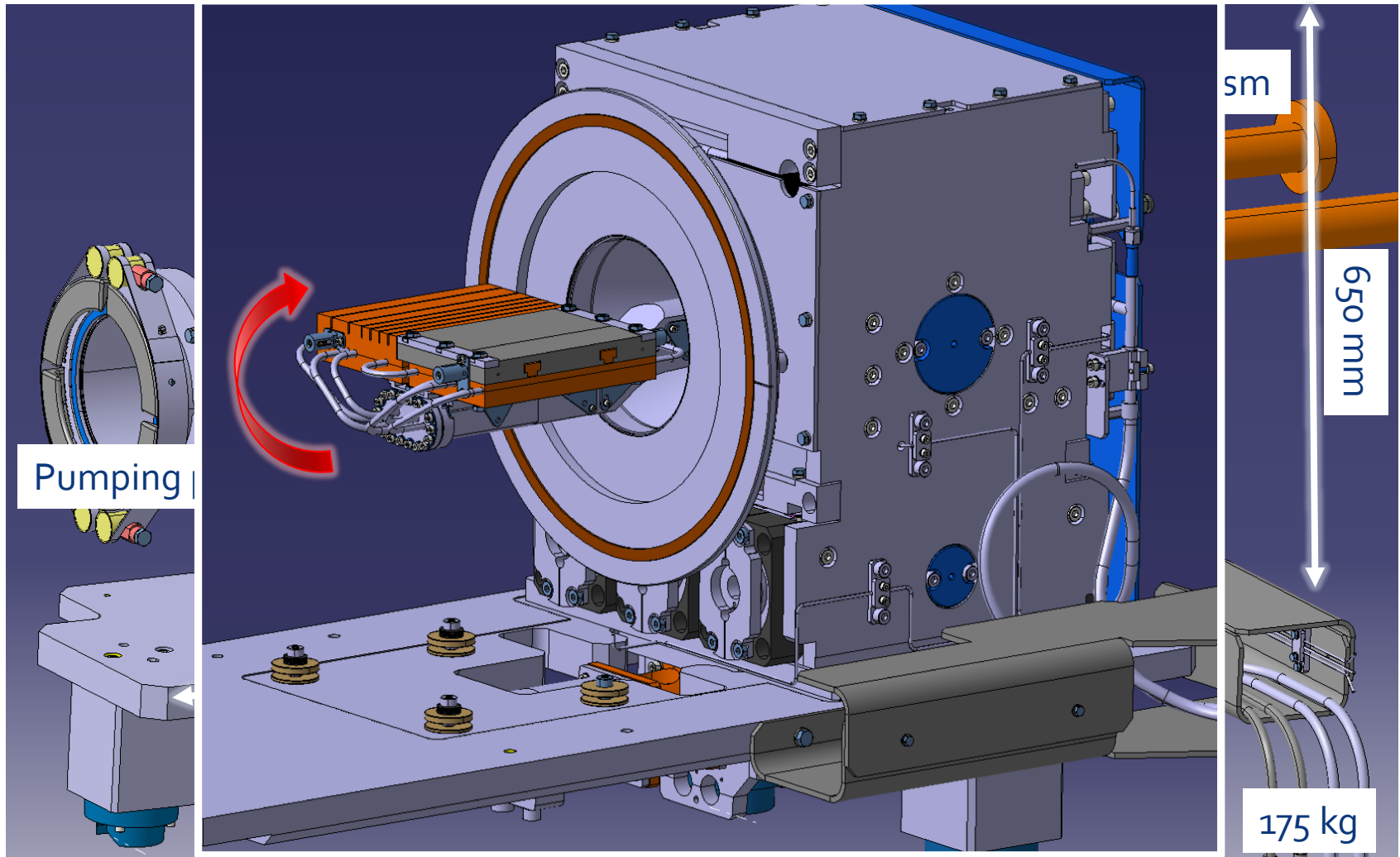
- Cycle time ~300 ms
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Design of the dump assembly

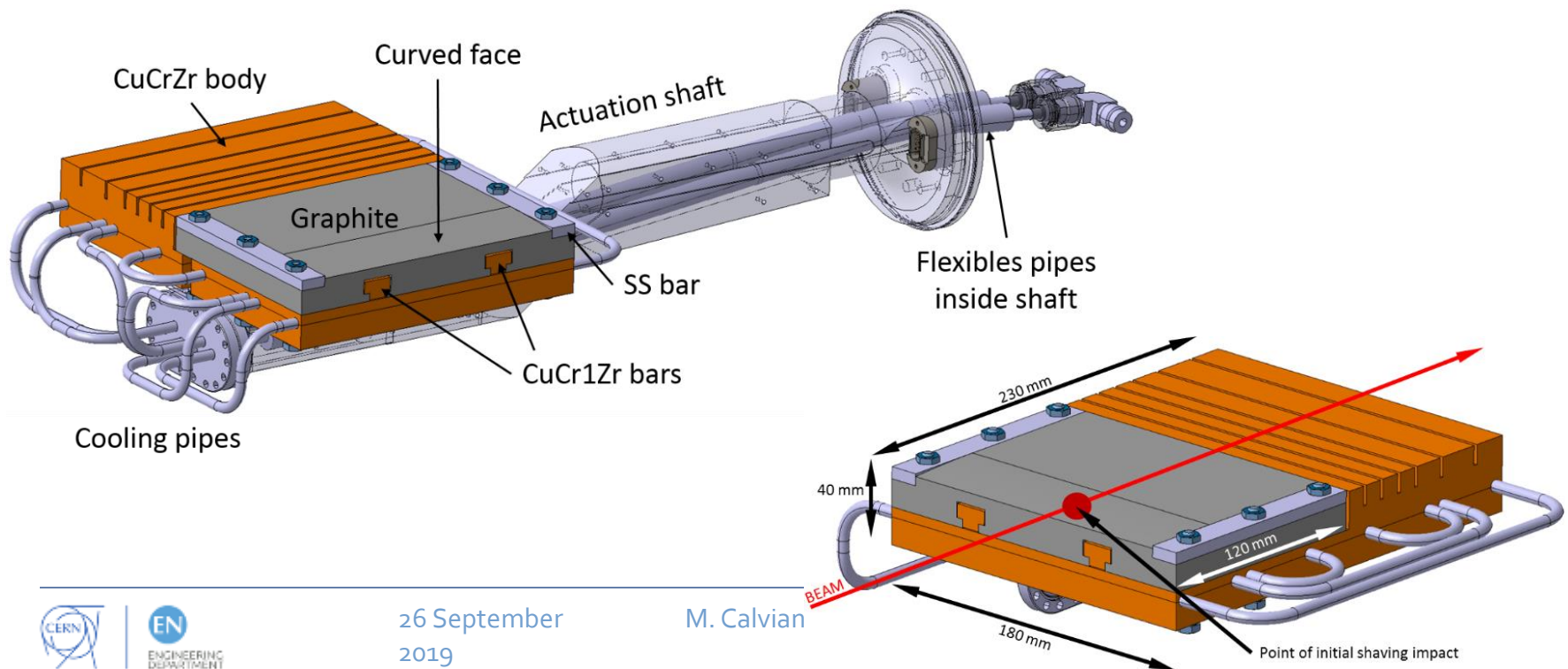


Design of the dump assembly



But how is the core built?

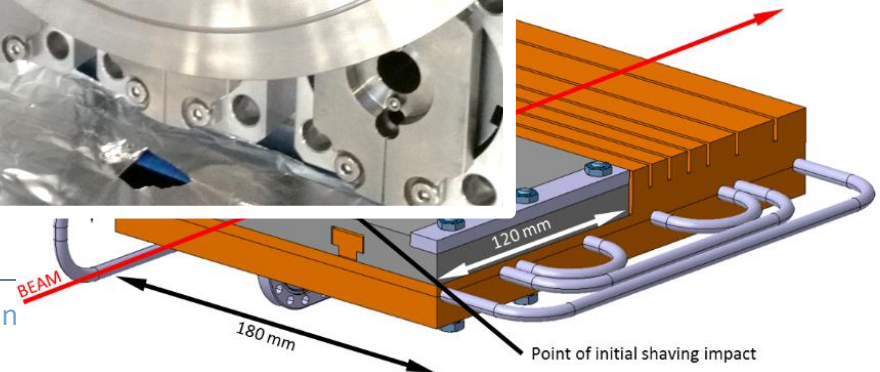
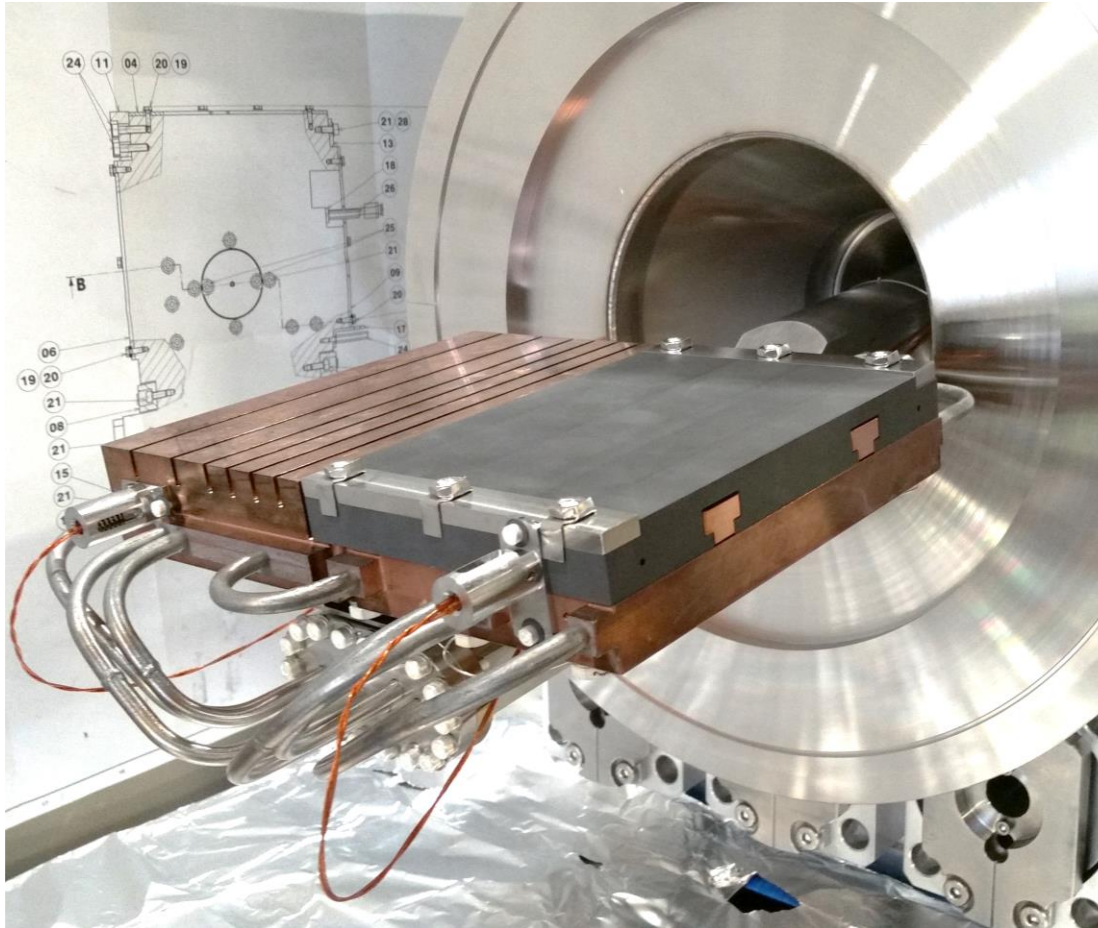
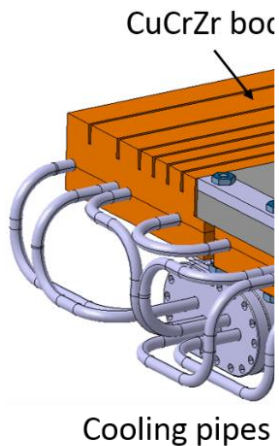
- Old generation was based on a water cooled Cu-OFE block
- Graphite (SGL7550) is required now to cope with higher beam intensities (and higher power) as well as CuCrZr owing to higher strength
- Only solution to remove the heat was based on **diffusion bonding by hot-isostatic pressing (HIP) between CuCrZr and 316L tubes**



But how is the core built?

- Old generation was based on a water-cooled Cu OFE block
- Graphite (and high)
- Only solid isostatic

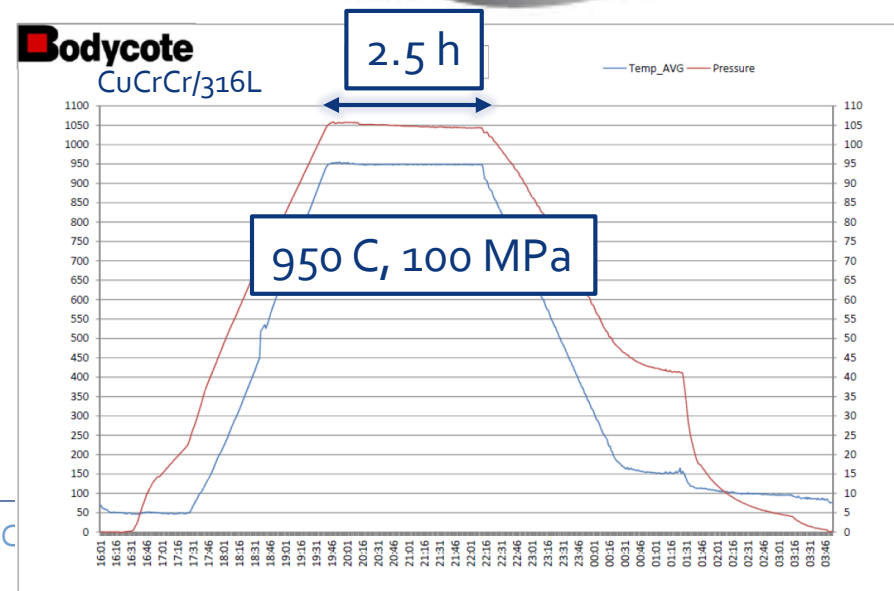
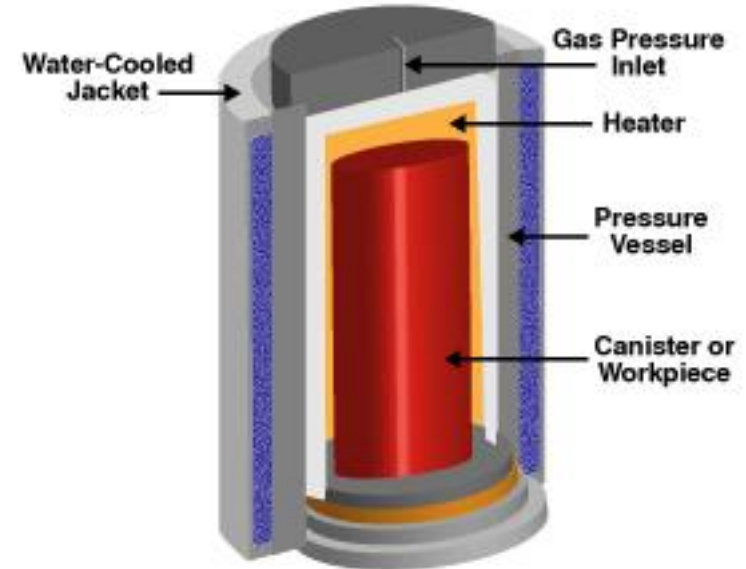
m intensities
th
nding by hot-



Intermezzo: diffusion bonding by HIP

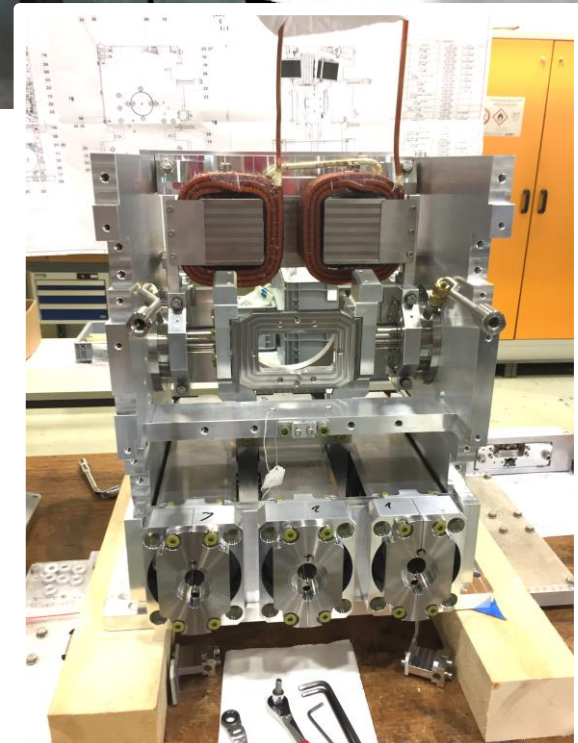
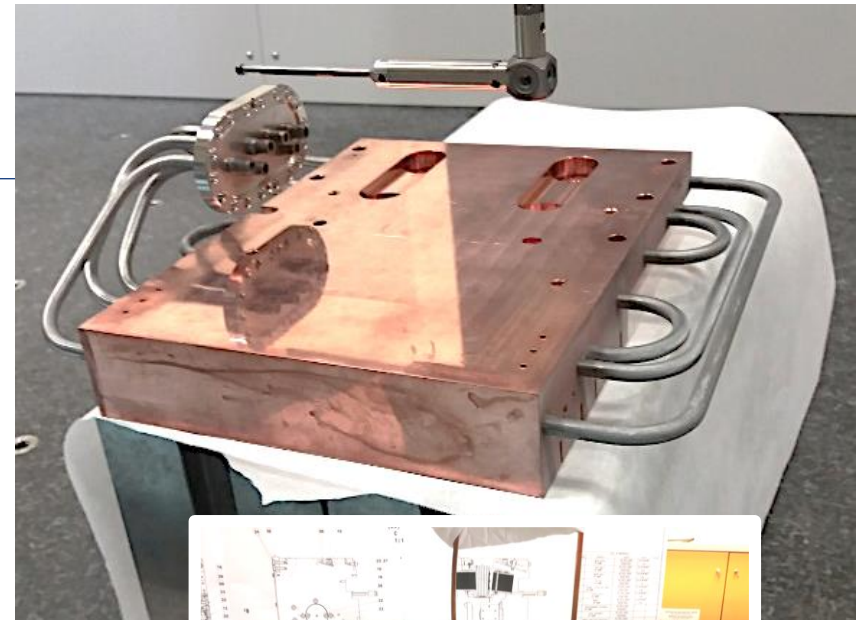
HOT ISOSTATIC PRESSING

- Hot Isostatic Pressing (HIP)
 - Maximum thermal efficiency (diffusion bonding all around the tube – perfect TCC)
 - Compatible with UHV
 - Versatile – different geometries possible
 - Reproducible
 - Sensitivity to tolerances but manageable *once known*

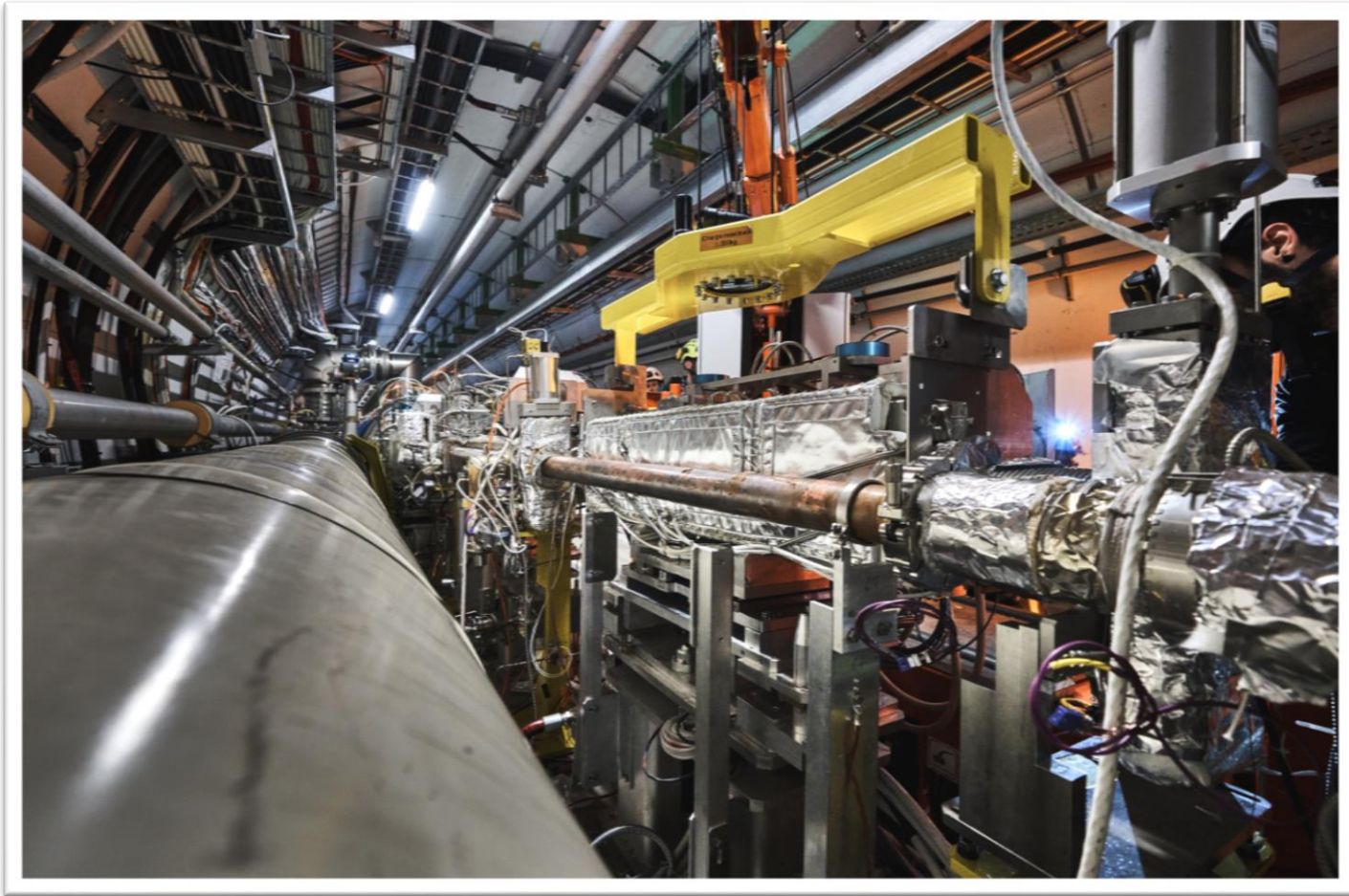


Challenges & status

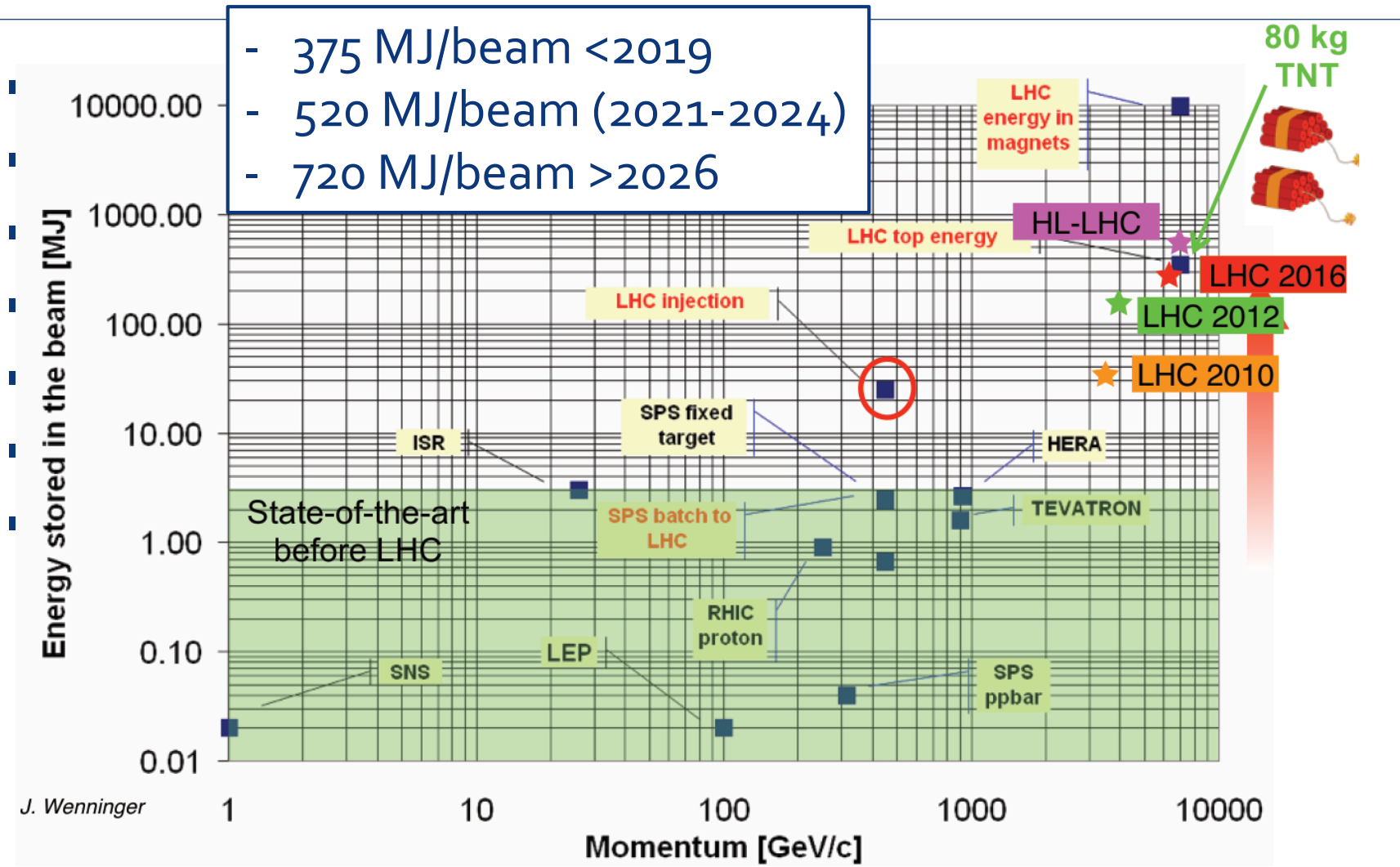
- Prototype dump successfully run for **1.5 M cycles**
 - ~10 years operation
- **Final dump** being assembled, together with the final HIP runs for the different cores (3x)
- Attention to material compatibility with UHV is critical
- **All on track for installation in the PS in April 2020**



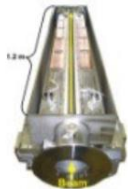
Challenge: High energy density



Roles of the collimation system



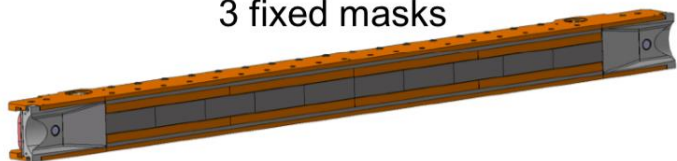
Collimation HL-LHC upgrade baseline



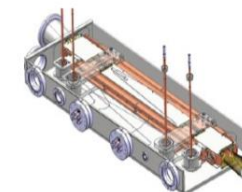
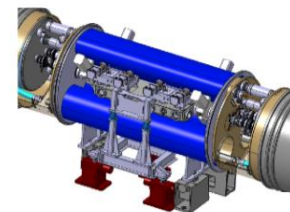
Completely new layouts
Novel robust material: CuCD

IR1+IR5, per beam:

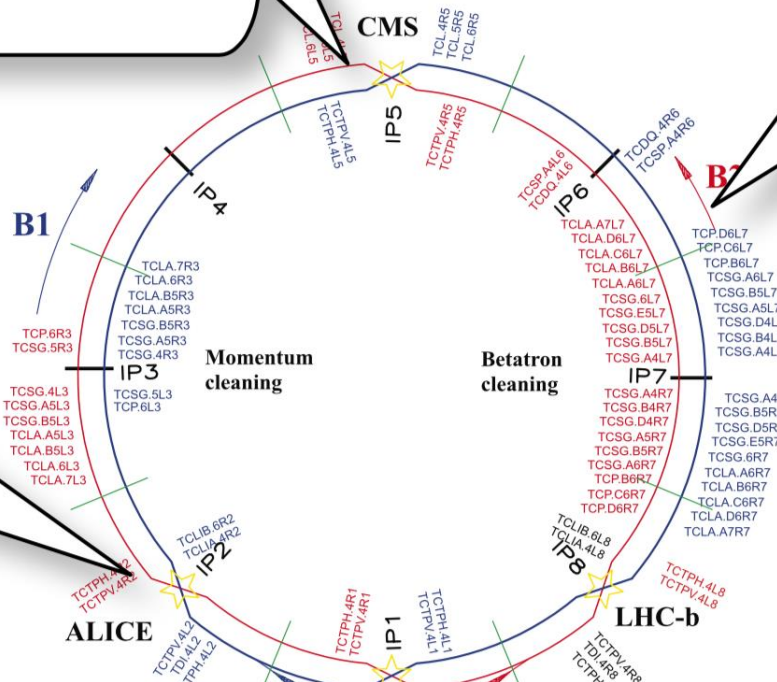
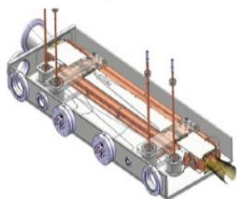
- 4 tertiary collimators (TCTs)
- 3 physics debris collimators
- 3 fixed masks



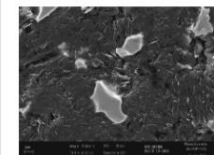
Cleaning: DS coll. + 11T dipoles, **1 unit per beam**



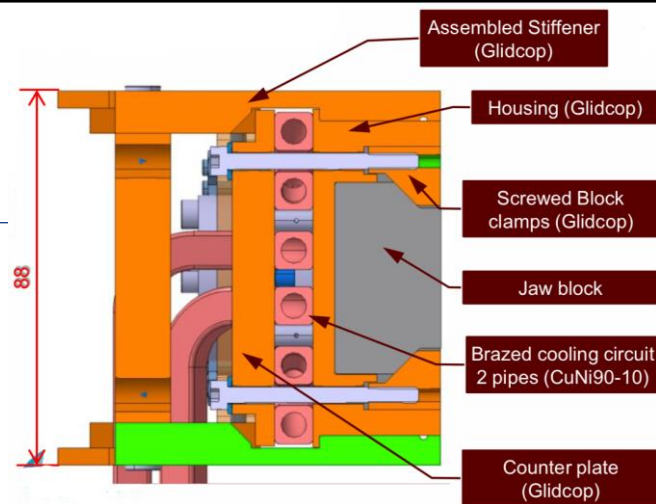
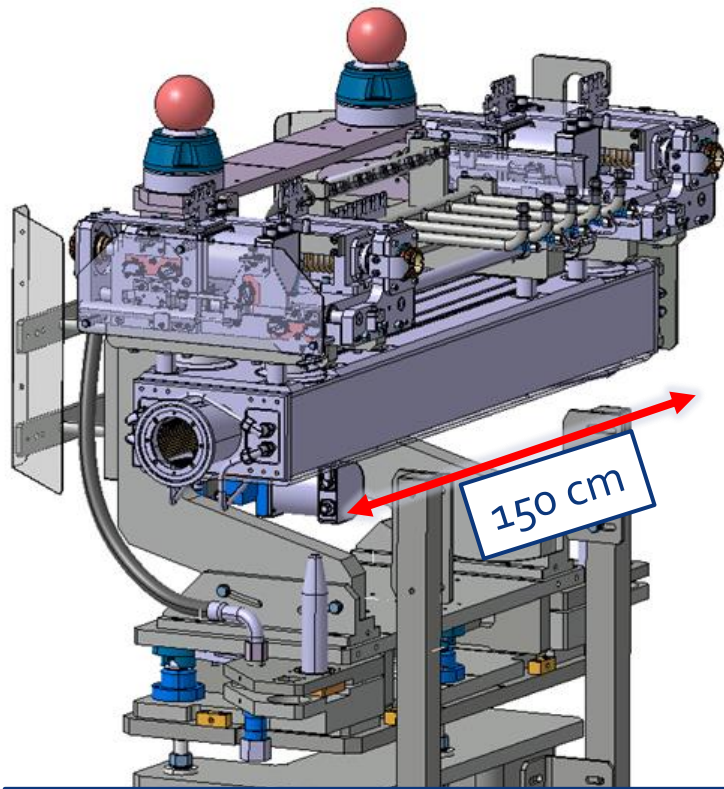
Ion physics: dispersion suppressor (DS) collimation



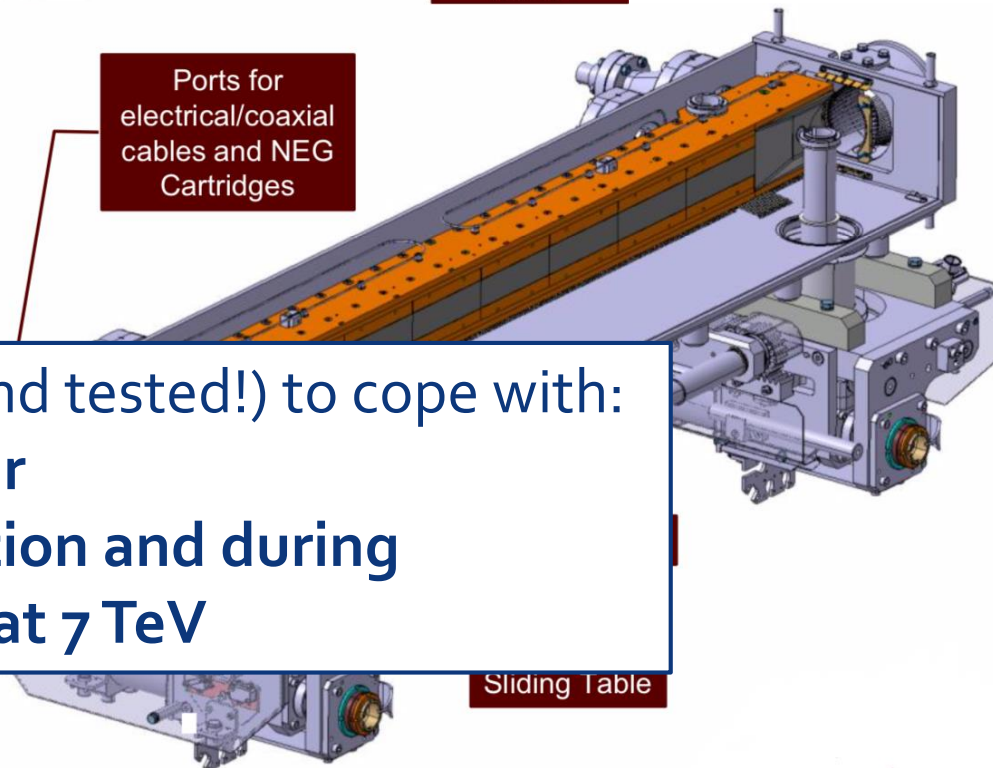
9 low-impedance, high robustness secondary collimators: coated MoGr



~20 new collimators being built for CERN LS2 (2019-2020)
... while ~40 foreseen for LS3



Ports for
electrical/coaxial
cables and NEG
Cartridges

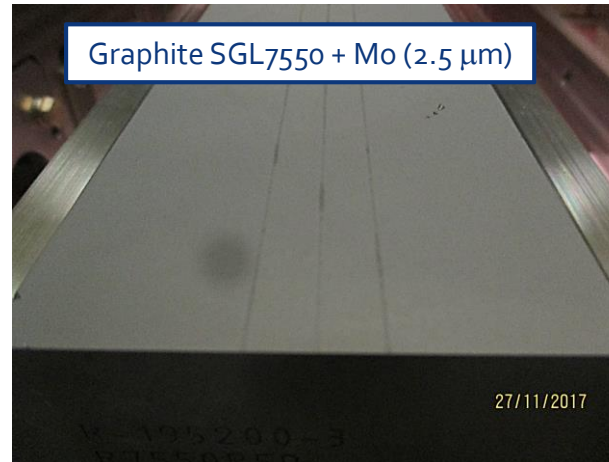
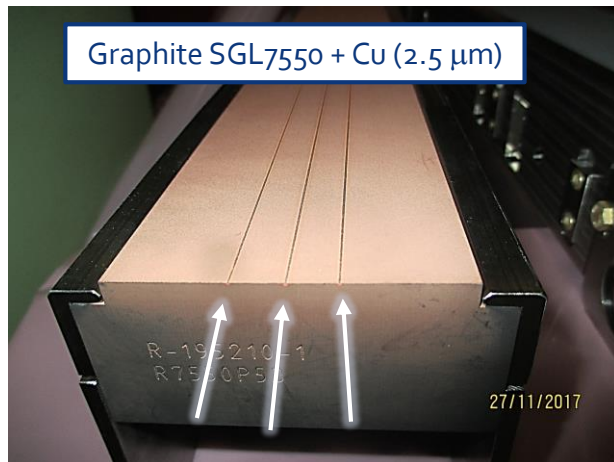


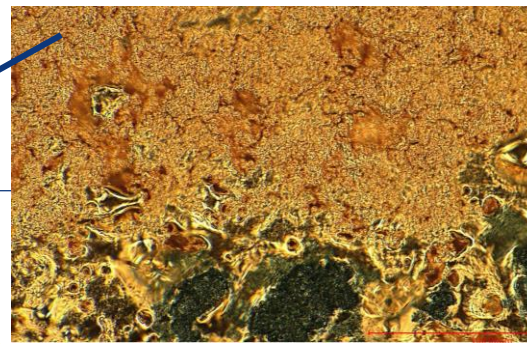
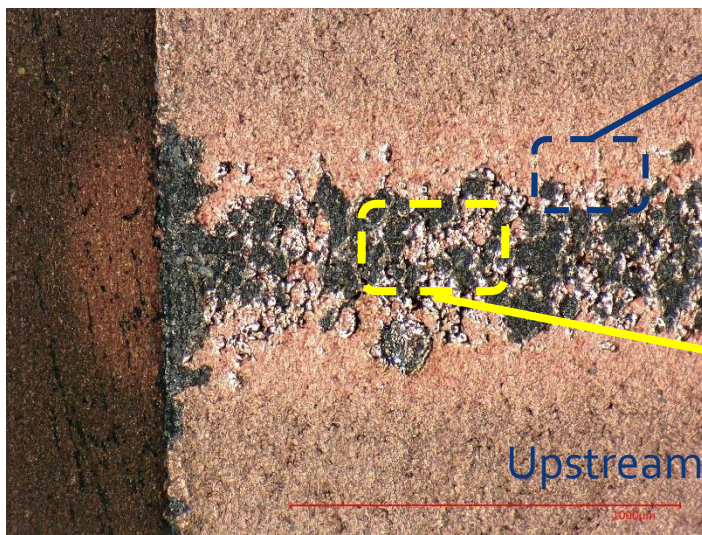
Each collimator jaw designed (and tested!) to cope with:

- **10 kW steady losses of 1 hour**
- **Direct beam impact at injection and during asynchronous beam dumps at 7 TeV**

Beam test of coating on collimators jaws

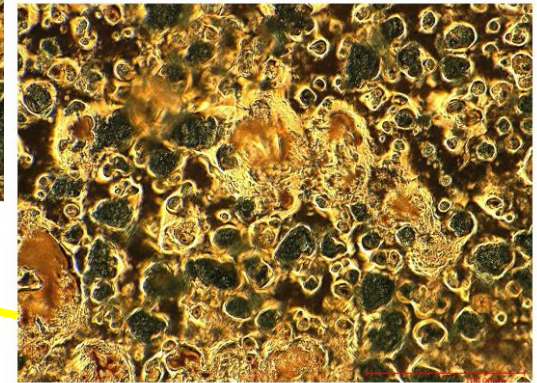
- HiRadMat test of **Cu and Mo coated graphite jaws** to understand **coating adherence under beam impact scenarios**
 - Same energy density as for a potential similar impact in the LHC
- Extensive campaign of simulations vs. experimental results





Limit of damage area

Melting and later solidification



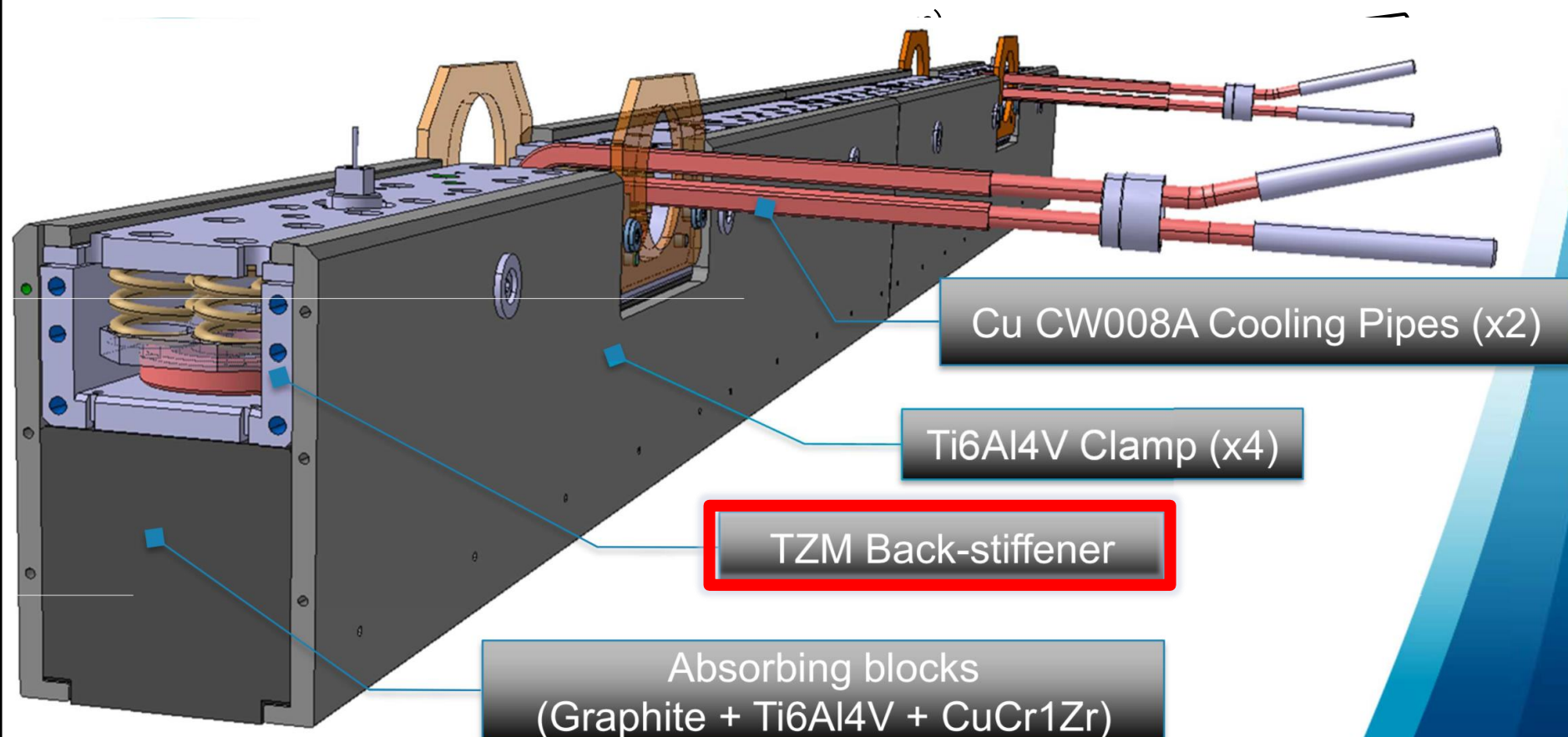
Surface damage detail in Cu coating: grazing impact



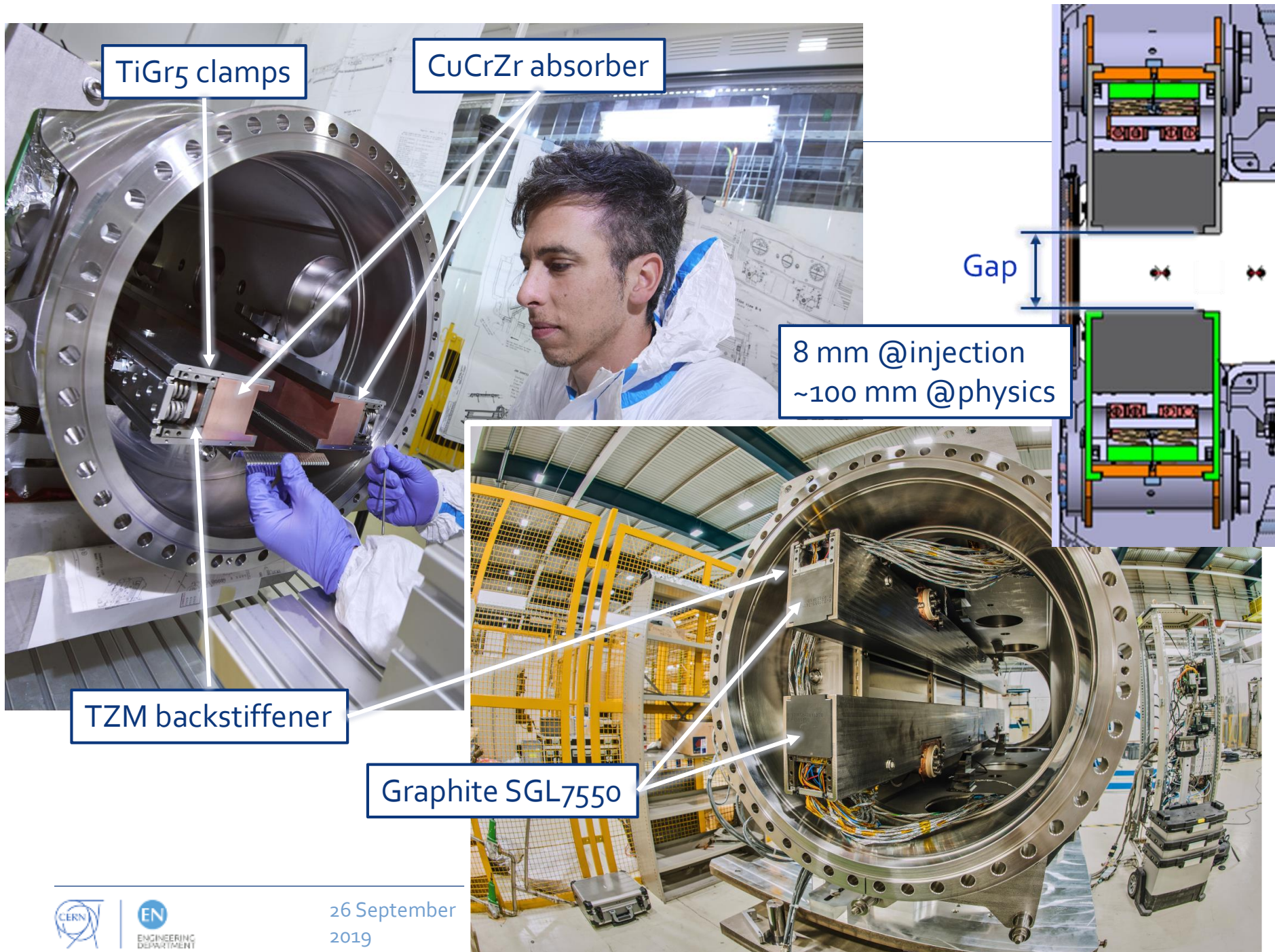
Surface damage detail in Mo coating: tilted impact

- Microscopic analysis confirms Cu coating **melting** as **predicted by simulations**
- **Mo coating not melting**, as predicted, but appearing to have spallation damage

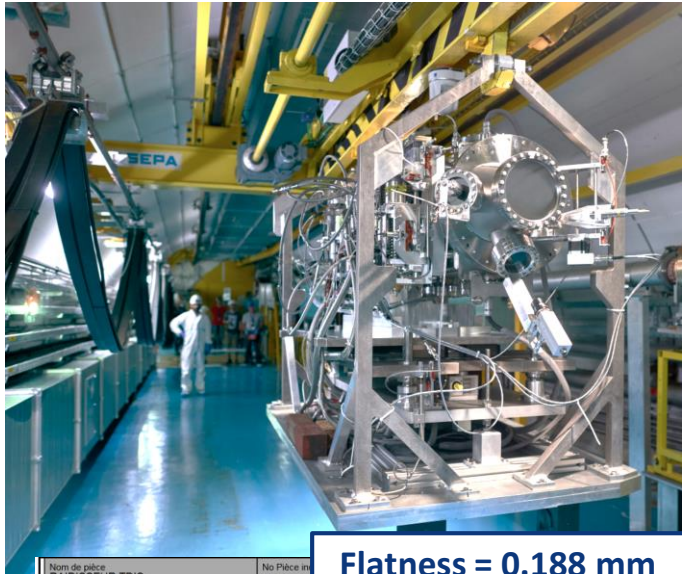
LHC Injection Beam Dump, currently being constructed



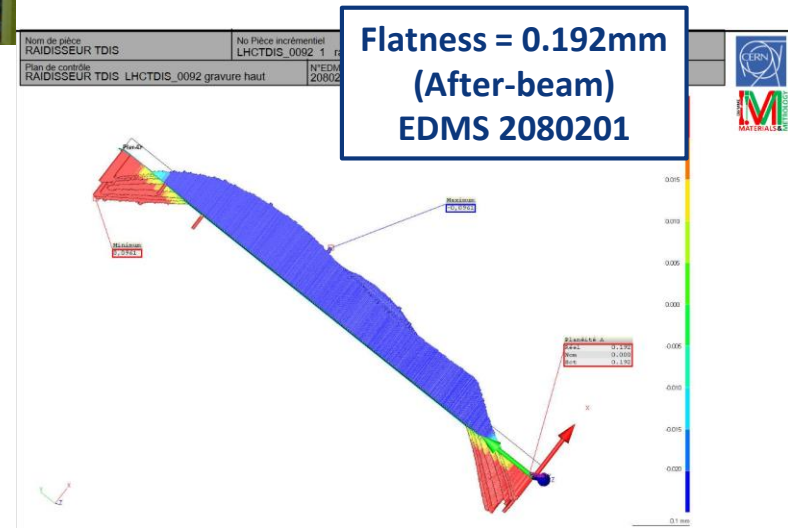
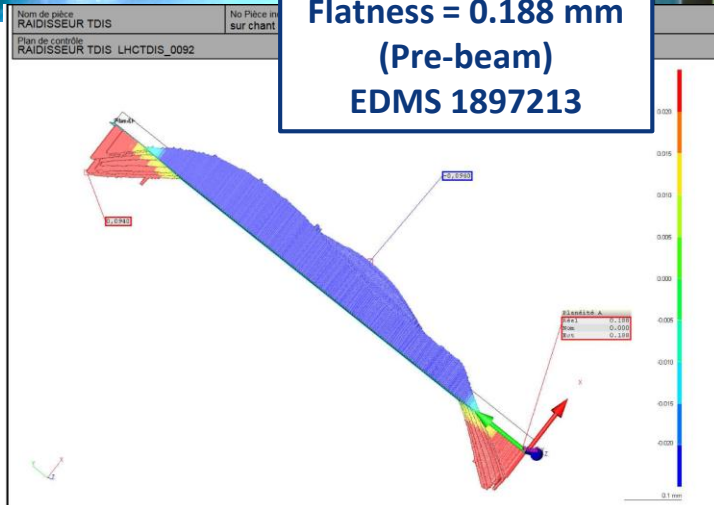
~200 μm flatness of absorbing blocks over the entire length



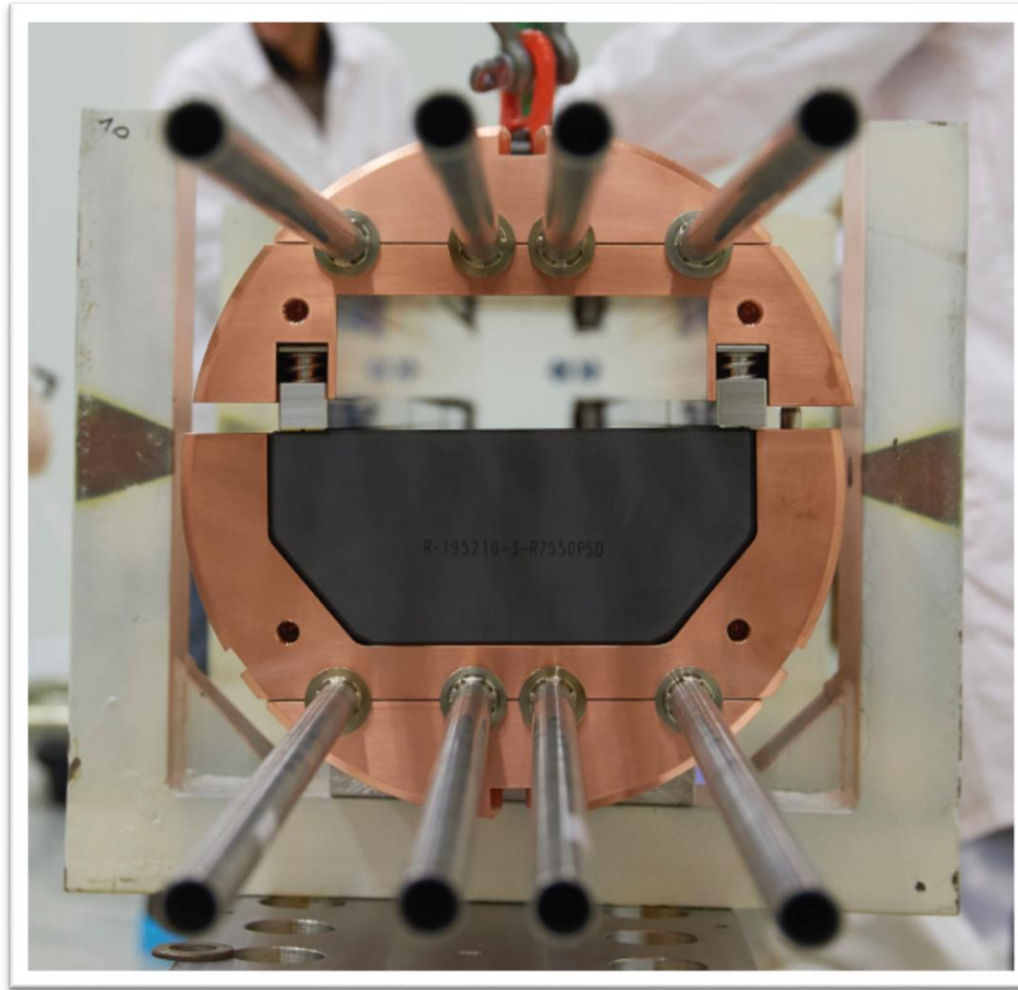
Validation of jaw resistance at HiRadMat



Dose rate $\sim 500 \text{ uSv/h}$ at contact



Challenge: High average deposited power



SPS internal beam dump

- Due to the specific design of the SPS, the dump is **internal** in UHV
- Heavily used in the machine, to allow flexibility and setting up beams – should **not** be a showstopper for operation and has to be reliable for all beams scenarios
- Up to 2018 at its 4th generation (TIDVG₄)
 - **70 kW** (max) dissipated power
 - **4.2 MJ** beam energy
- For LHC Injector Upgrade (LIU) Project → 5th generation is being built
 - **250 kW** dissipated power
 - **5.3 MJ** beam energy



SPS internal beam dump

- Due to the specific design of the SPS, the dump is **internal** in UHV
- Heavily used in the machine, to allow flexibility and setting up beams – should **not** be a showstopper for operation and has to be reliable for all beams scenarios

Challenges:

- Materials with high robustness against beam impact
 - UHV compatibility
 - Good cooling power and thermal contact with absorbing materials
 - Limited space longitudinally
 - High residual dose rate
 - Reliability on the long-term
- **250 kW** dissipated power
 - **5.3 MJ** beam energy



What could happen with insufficient cooling?



Endoscopy results from a previous generation internal dump, which operated until 2012
→ Complete removal of Al and focus on thermal contact with Cu sink

Window: 163.4 x 47 mm

The copper rests in the stainless tube.

Position and Orientation is guaranteed by the keys.

The top gap is 4mm

Cast Iron Yoke

Copper Sheet
For thermal contact
With yoke

Compression
Spring

Guiding key

Injected beam

Circulating beam

Dumped beam
(painted)

30 cm

Stainless Steel
Vacuum chamber

Copper Core

Water Cooling

Guiding key

Graphite 3500mm
Copper 400mm
Tungsten 400mm

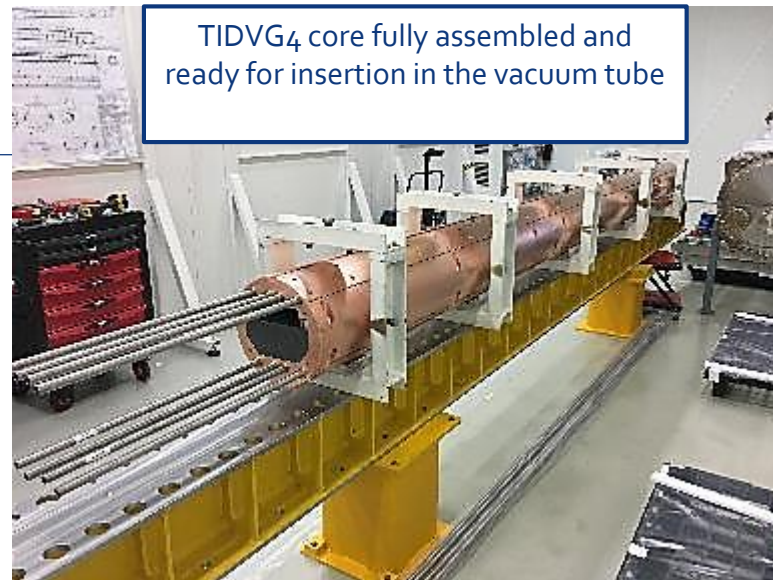
Graphite inside the CuCrZr core



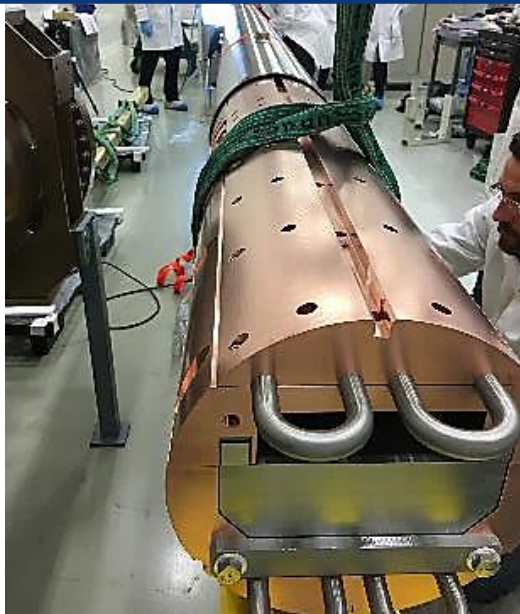
Medium/high-Z absorber



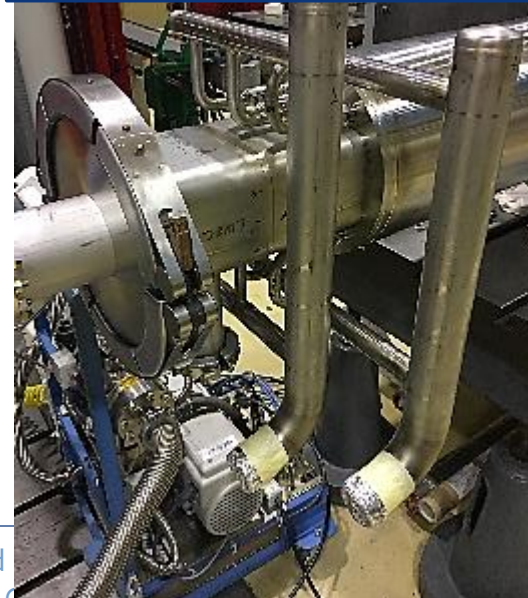
TIDVG₄ core fully assembled and ready for insertion in the vacuum tube



TIDVG₄ core being pulled into the vacuum chamber



Final leak detection (upstream w/ water manifolds)



TIDVG₄ core fully inserted (upstream)



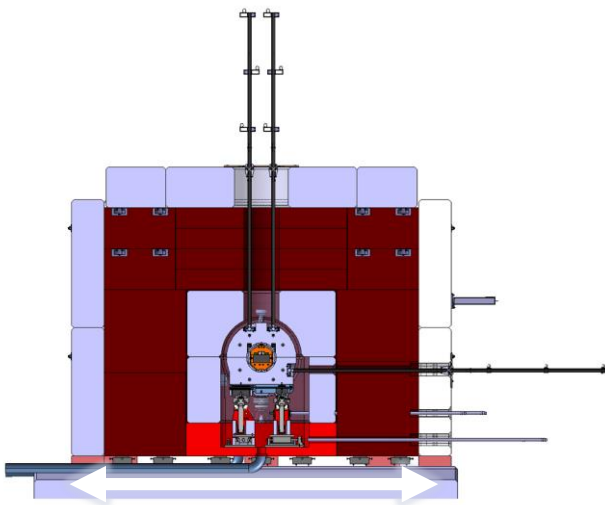
But with the LHC Injector Upgrade Project...

...the current dump will not be sufficient:

1. Need to cope with **higher beam power** (and deposited)
2. Need to comply with **strict radiation protection rules**

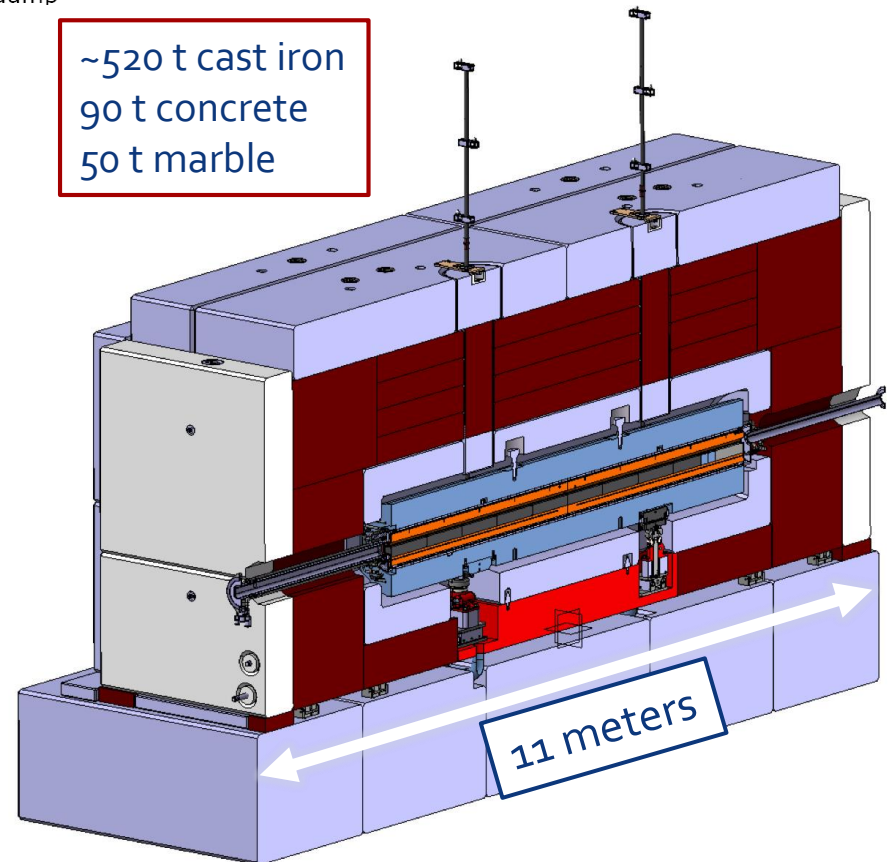
Table 3: HL-LHC beam load parameters for internal dump

Parameter	Unit	HL-LHC Standard		LIU-80
		Low	High	Low
Energy				
Brightness				
Stored energy				
Pulse period				
Max. dumps / 1				
Average power				
Consecutive du				



6 meters

~520 t cast iron
90 t concrete
50 t marble



~20 tons

~5 meters

Innermet180

TZM

~9.2 meters

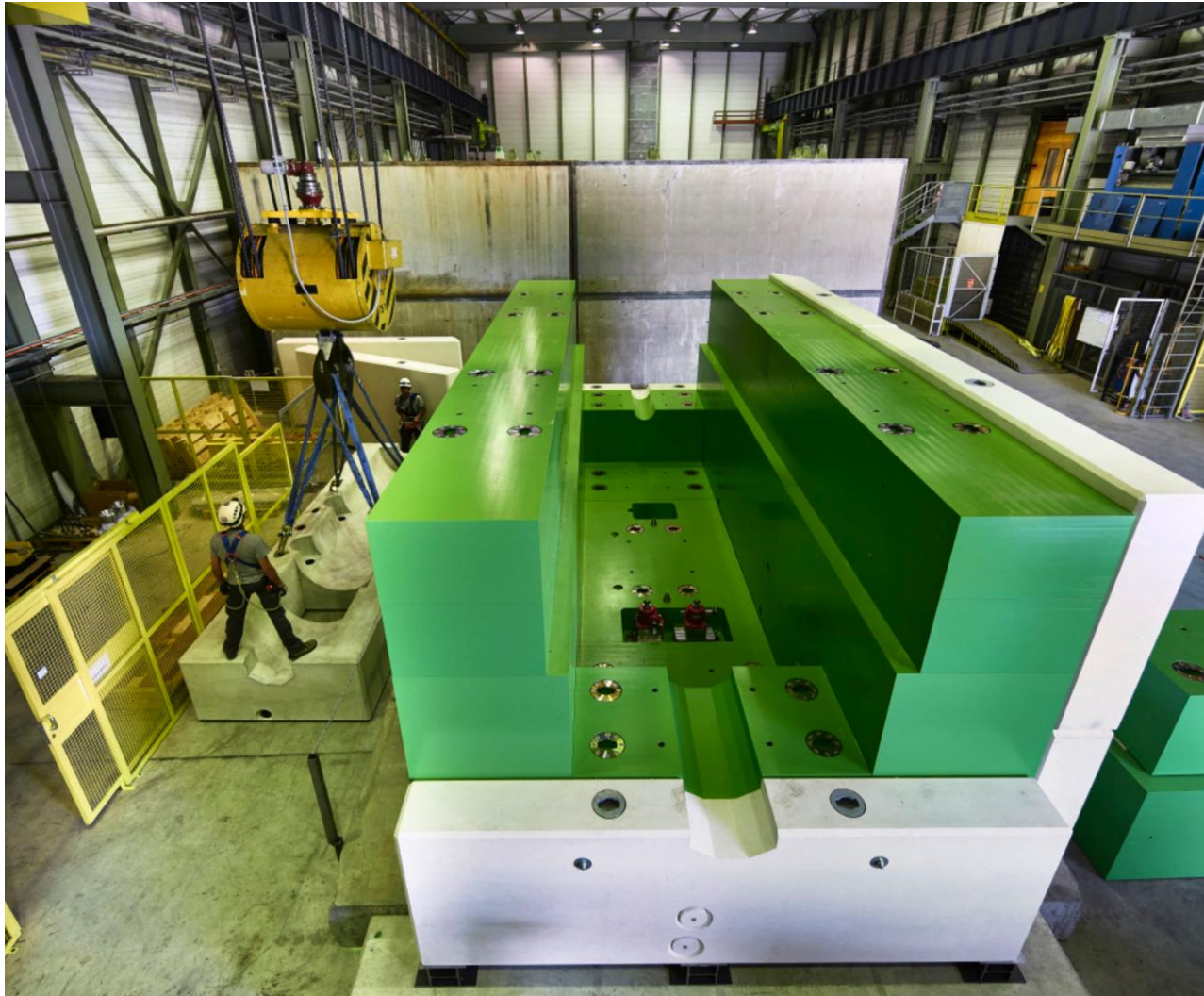
Graphite SGL7550

CuCrZr jacket,
HIPed to 316L
tubes (water
cooling)

Circulating beam

Dumped beam
(painted)

... to reality!



... to reality!



... to reality!

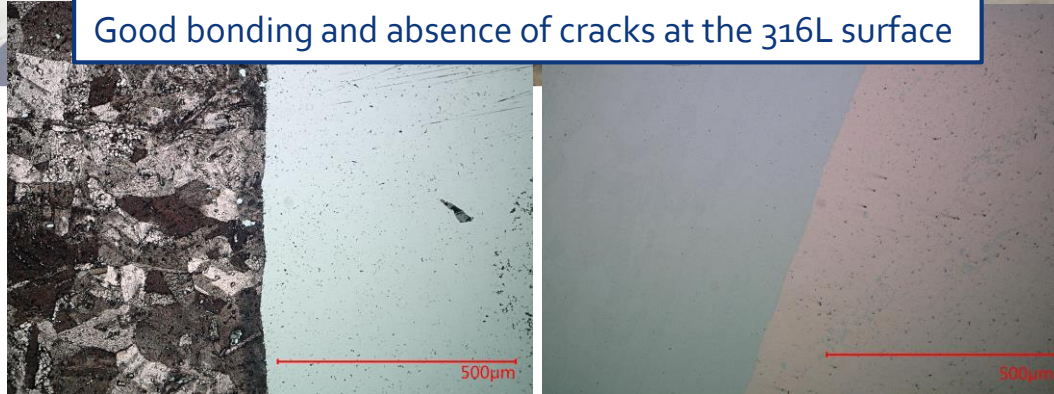


Core being design with HIP technology

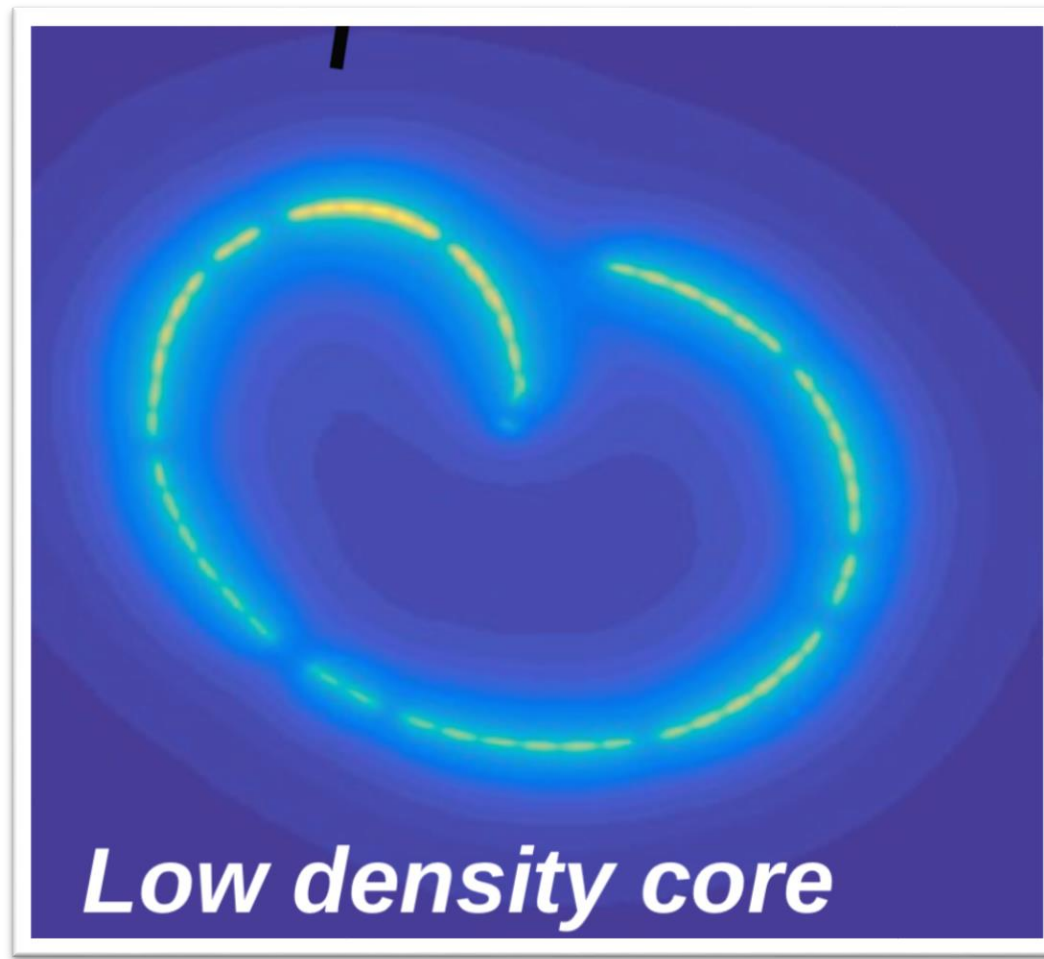
All items on track for production and installation of the new dump in SPS during summer 2020



Good bonding and absence of cracks at the 316L surface

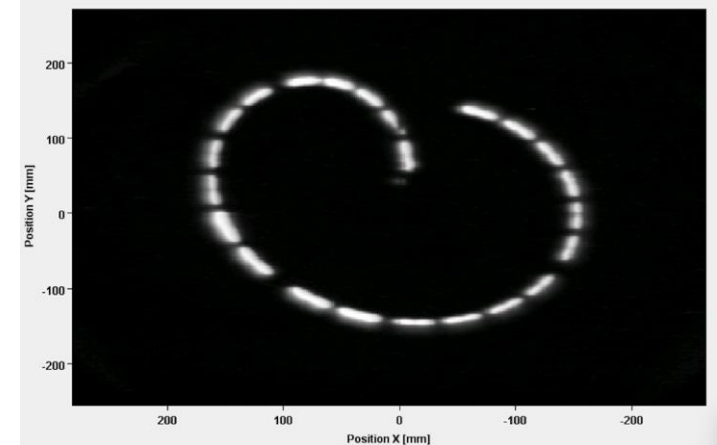
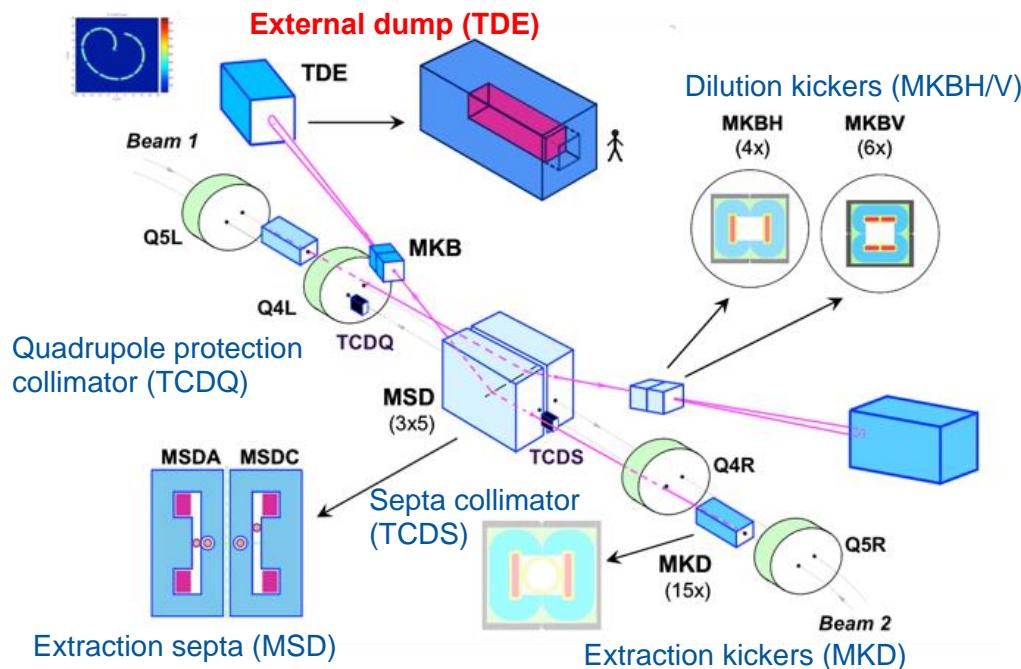


Challenge: High beam energy



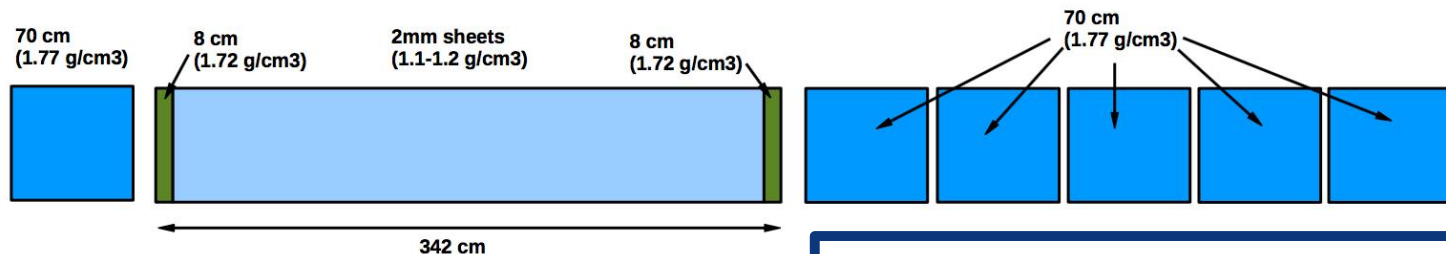
LHC external beam dump

- Circulating beams in the LHC have a kinetic energy of around **300 MJ/beam** (until 2018) → the LBDS is taking care of its extraction from the ring
- **Beam diluted** over the extraction time of **84 μs**



LHC external beam dump

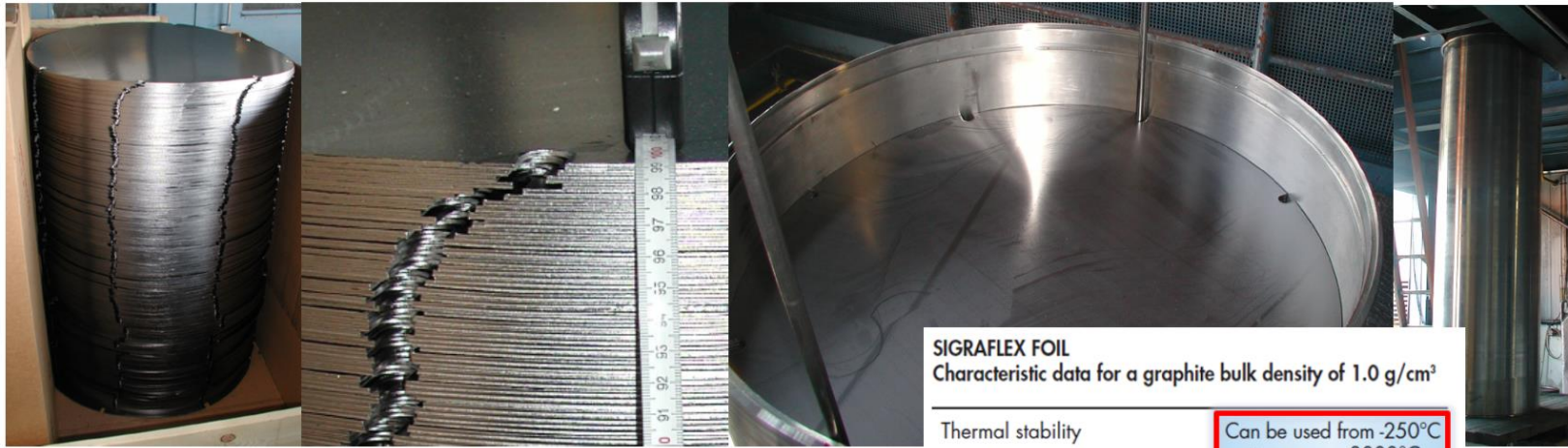
High and low-density segments:



Low-density flexible Graphite sheets:

Currently:

- **240 MJ** deposited in graphite
- **20 MJ** in the 318L shell



SIGRAFLEX FOIL

Characteristic data for a graphite bulk density of 1.0 g/cm³

Thermal stability

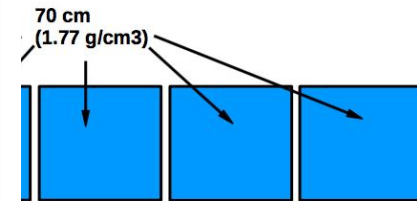
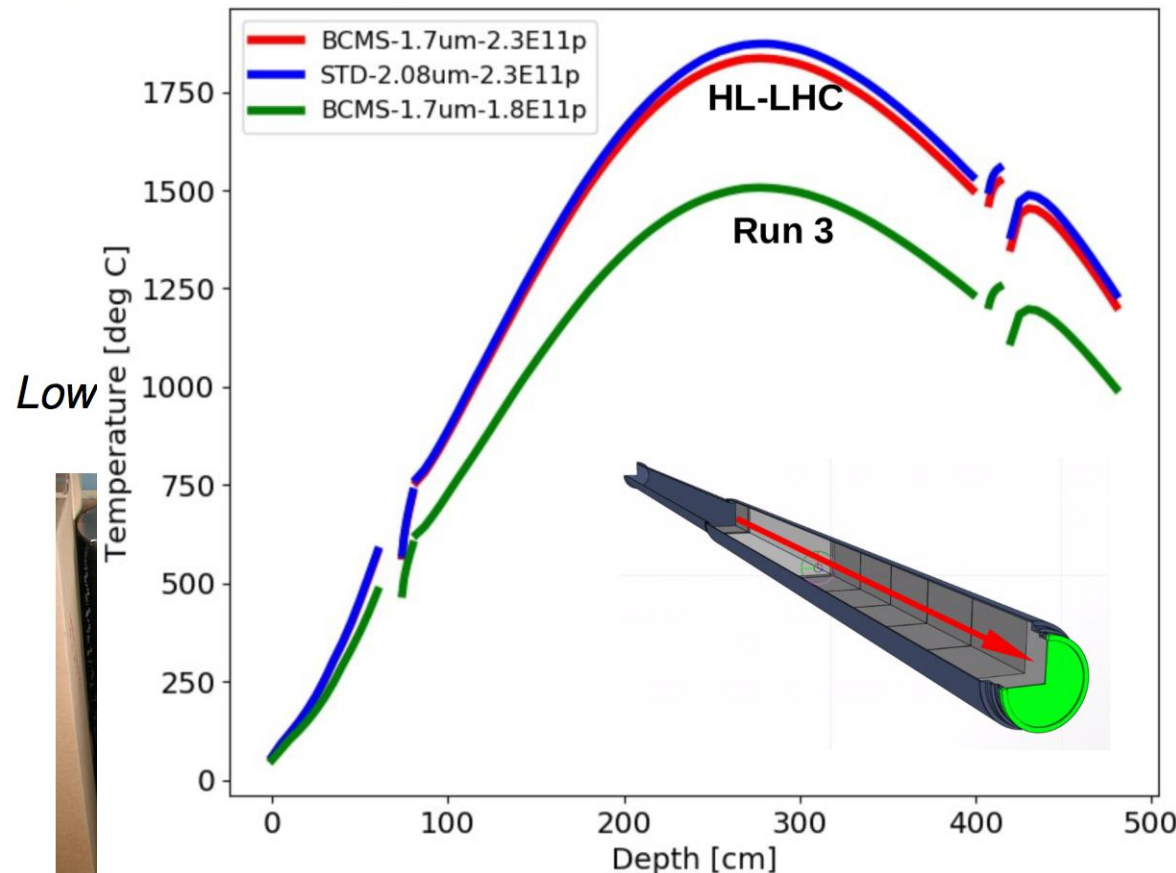
Can be used from -250°C
up to approx. 3000°C
(in protective gas)

Sublimation temperature °C

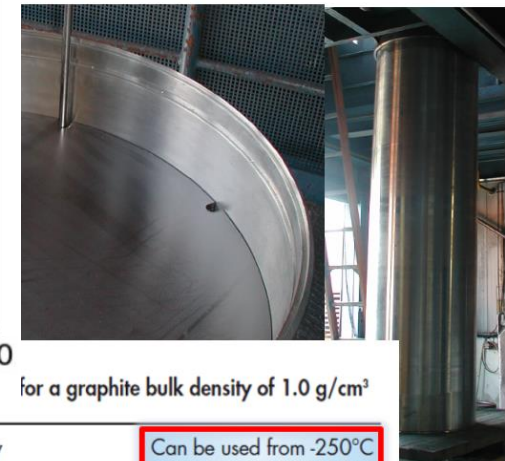
> 3000

LHC external beam dump

High and low-density segments:



deposited in graphite
the 318L shell



for a graphite bulk density of 1.0 g/cm³

Thermal stability

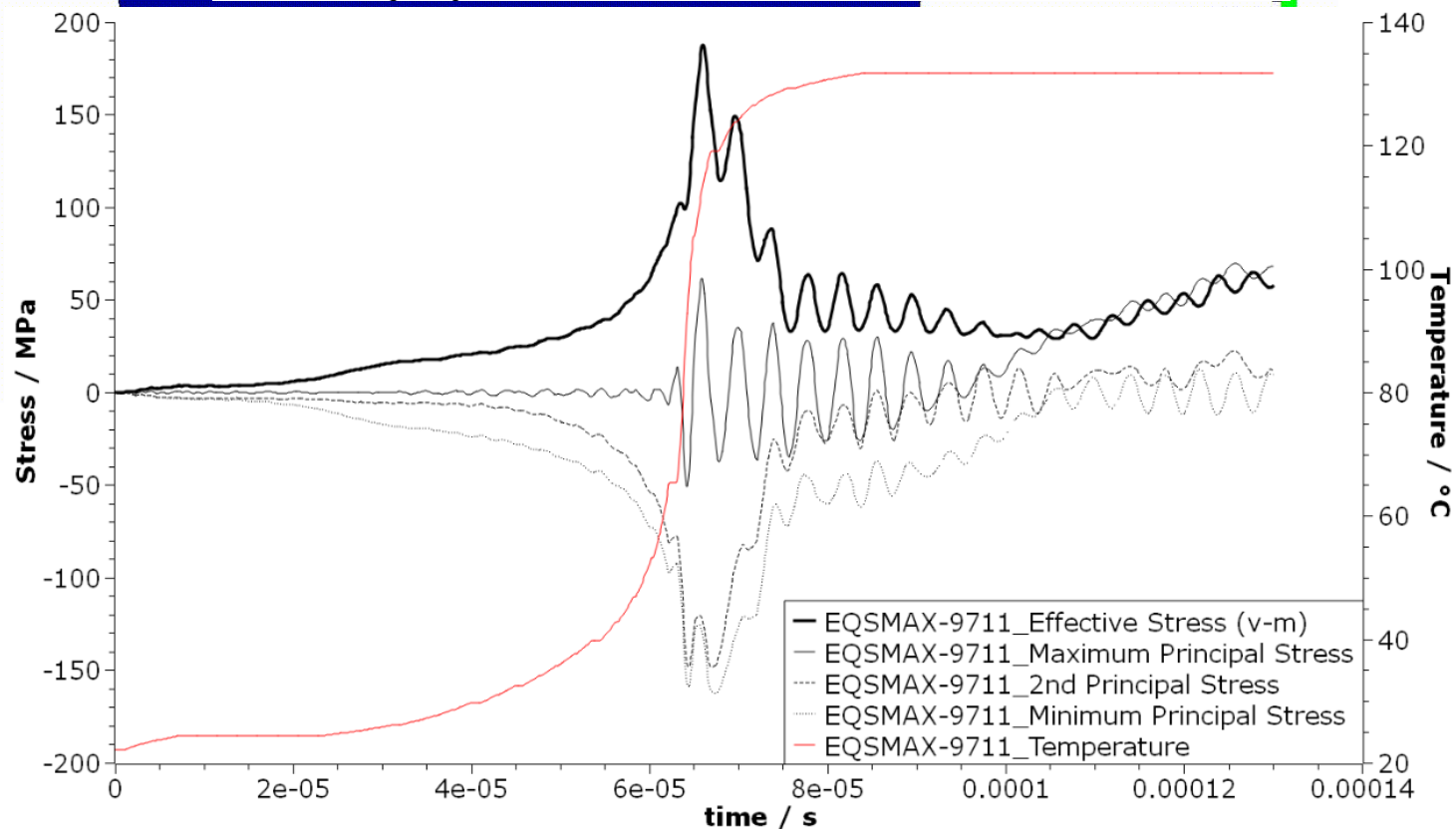
Can be used from -250°C
up to approx. 3000°C
(in protective gas)

Sublimation temperature °C

> 3000

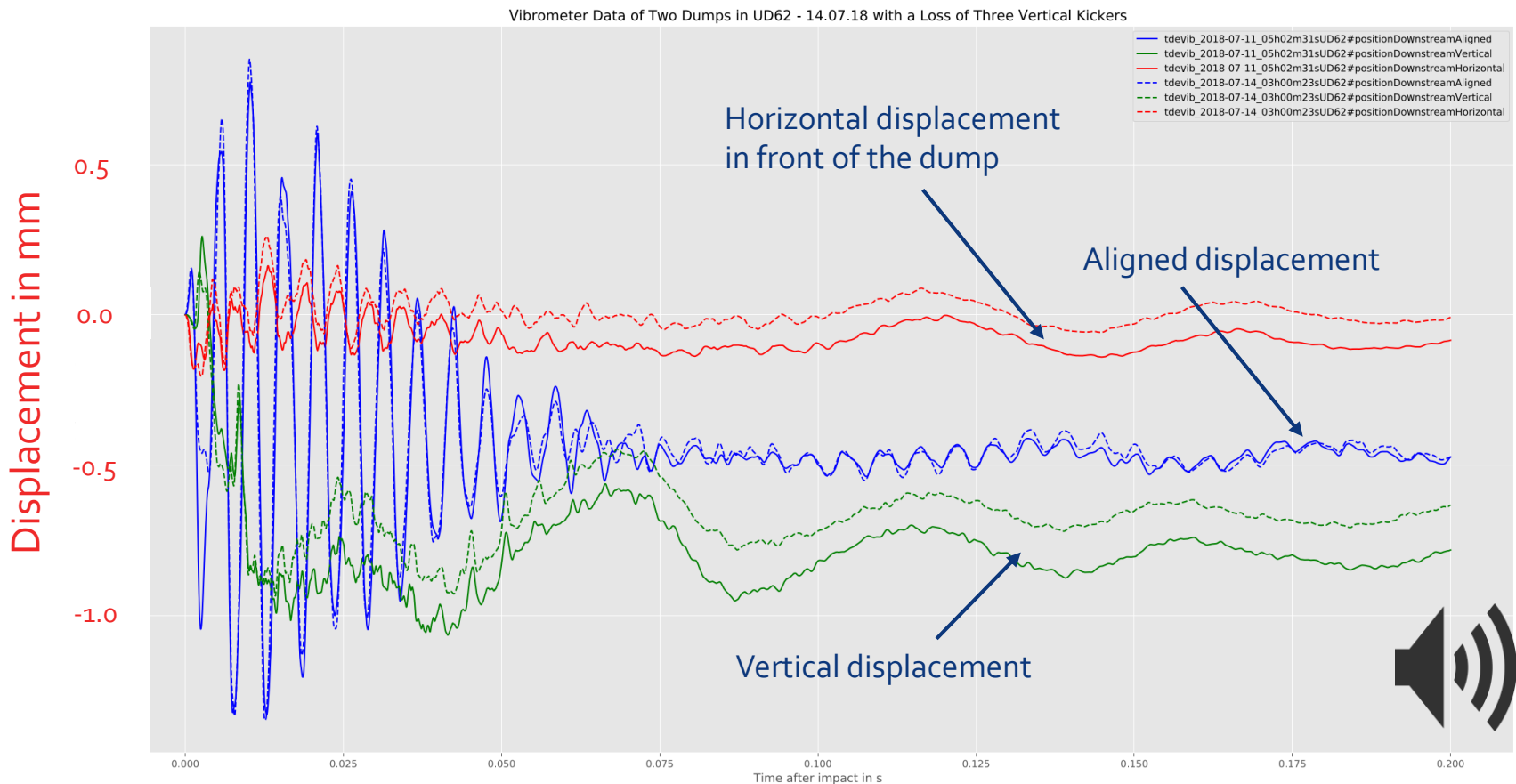
1.8775174e+08
 1.8149335e+08
 1.7523496e+08
 1.6897657e+08
 1.6271818e+08
 1.5645979e+08
 1.5020140e+08
 1.4394300e+08
 1.3768461e+08
 1.3142622e+08
 1.2516783e+08
 1.1890944e+08
 1.1265105e+08
 1.0639265e+08

Titanium (G2) - Maximum Stress - HLLHC25ns - 6V2H



Recent information and future plans

- Over the course of the last 2 years, several N₂ leaks occurred in the nitrogen line close to the dump → dump was then instrumented

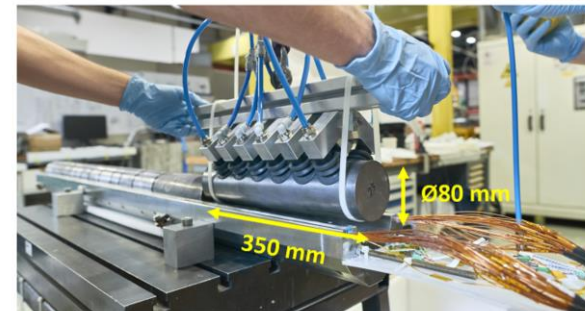
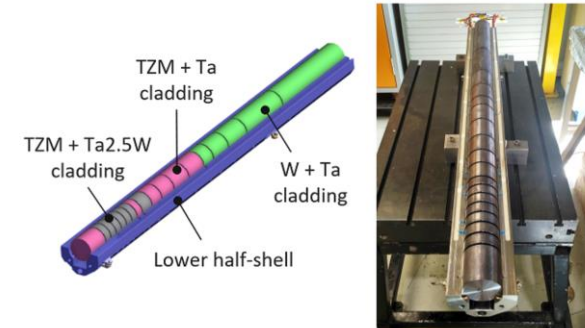


Future plans on LHC beam dump

- Several upgrade plans are foreseen during LS2, to reduce dose to personnel during interventions to fix the leaks
 - Including **upgrade of the downstream dump** window (TiGr2 to **TiGr5**) and improved **instrumentation**
- 1. **Optimize the graphite core configuration** for HL-LHC, since temperature up to 2000 °C for regular operation might not be acceptable for the core (*cyanide formation, sublimation, etc.*)
- 2. **Sudden thermal expansion** of the 318L (**60 °C in 84 μs**, due to 20 MJ, 80 MJ/m³) might be responsible for the **significant vibrations** and **permanent displacement** of the dump

Conclusions

- **Beam intercepting devices and Targetry technologies** at CERN are being upgraded due to **LIU** and **HL-LHC Project requirements**
- **Several other topics not discussed**, including pbar target, neutron targets, ISOLDE as well as future project such as Beam Dump Facility & FCC
- All activities are requiring **significant technological development** and **material R&D**
- Collaboration such as RaDIATE on radiation damage (including J-PARC!) providing an excellent platform for developments





Thanks!

16 September
2019

M. Calviani (CERN) - Targetry and beam intercepting devices
activities at CERN

